

Dual 1.4A, Single 2.8A Step-Down Silent Switcher μ Module Regulator

FEATURES

- Two Complete Step-Down Switching Power Supplies
- Low Noise Silent Switcher® Architecture
- CISPR22 Class B Compliant
- CISPR25 Class 5 Compliant
- Wide Input Voltage Range: 3V to 40V
- Wide Output Voltage Range: 0.8V to 10V
- 1.4A Continuous Output Current per Channel at 24V_{IN}, 3.3V_{OUT}, T_A = 85°C
- Multiphase Parallel Operation to Increase Current
- Selectable Switching Frequency: 300kHz to 3MHz
- Compact Package (6.25mm × 6.25mm × 2.22mm) Surface Mount BGA

APPLICATIONS

- Automated Test Equipment
- Distributed Supply Regulation
- Industrial Supplies
- Medical Equipment

DESCRIPTION

The LTM8078 is 40V_{IN}, dual 1.4A/single 2.8A step-down Silent Switcher μ Module® regulator. The Silent Switcher architecture minimizes EMI while delivering high efficiency at frequencies up to 3MHz. Included in the package are the controllers, power switches, inductors, and support components. Operating over a wide input voltage range, the LTM8078 supports output voltages from 0.8V to 10V, and a switching frequency range of 300kHz to 3MHz, each set by a single resistor. Only the bulk input and output filter capacitors are needed to finish the design. The LTM8078 product video is available on website. [📺](#)

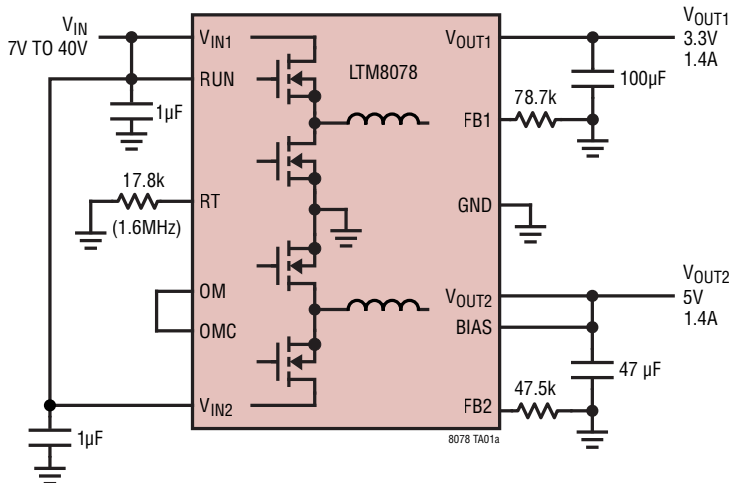
The LTM8078 is packaged in a compact (6.25mm × 6.25mm × 2.22mm) over-molded Ball Grid Array (BGA) package suitable for automated assembly by standard surface mount equipment. The LTM8078 is available with SnPb (BGA) or RoHS compliant.

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[📺](#) Click to view associated Video Design Idea.

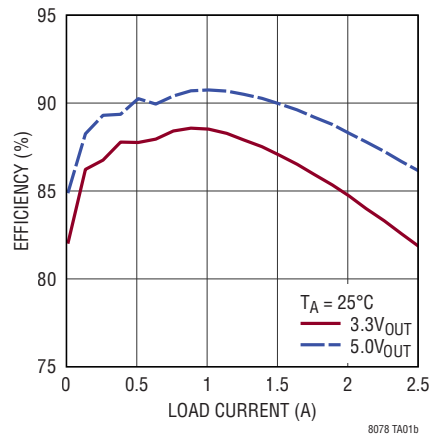
TYPICAL APPLICATION

3.3V_{OUT} and 5V_{OUT} from 7V to 40V Dual Step-Down Converter



PINS NOT USED:
TRSS1, TRSS2, PG1, PG2, CLKOUT, SYNC

Efficiency, V_{IN} = 24V, BIAS = 5V



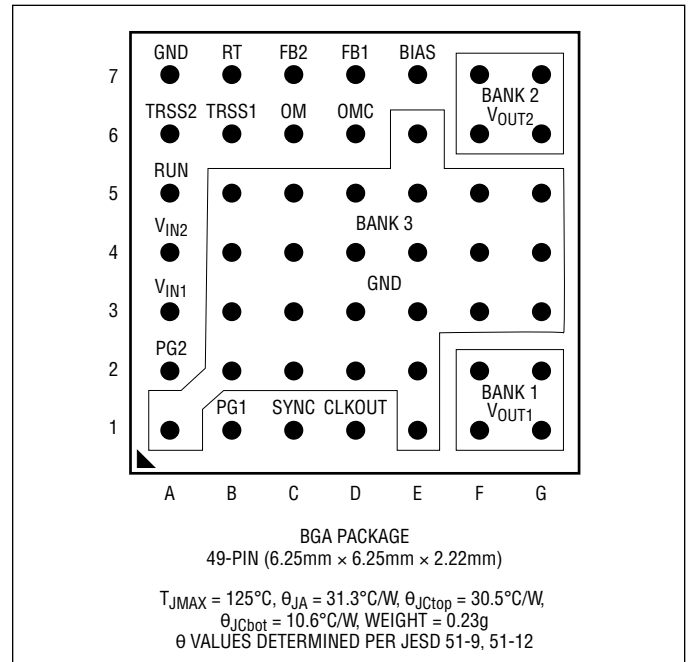
LTM8078

ABSOLUTE MAXIMUM RATINGS

(Note 1)

V_{INn} , RUN, PG_n	42V
V_{OUTn} , BIAS	10V
FB_n , OM, OMC, $TRSS_n$, RT	4V
SYNC	6V
Maximum Internal Temperature (Note 2)	125°C
Storage Temperature	-55°C to 125°C
Peak Solder Reflow Package Body Temperature ..	260°C

PIN CONFIGURATION



ORDER INFORMATION

PART NUMBER	PAD OR BALL FINISH	PART MARKING		PACKAGE TYPE	MSL RATING	TEMPERATURE RANGE (SEE NOTE 2)
		DEVICE	FINISH CODE			
LTM8078EY#PBF	SAC305 (RoHS)	8078	1	BGA	3	-40°C to 125°C
LTM8078IY#PBF			0			
LTM8078IY	SnPb (63/37)					

- Device temperature grade is indicated by a label on the shipping container.
- Pad or ball finish code is per IPC/JEDEC J-STD-609.
- BGA Package and Tray Drawings
- This product is not recommended for second side reflow. This product is moisture sensitive. For more information, go to [Recommended BGA PCB Assembly and Manufacturing Procedures](#).

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the specified operating internal temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{IN1} = V_{IN2} = 12\text{V}$, $\text{RUN} = 2\text{V}$ unless otherwise noted (Note 2).

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Minimum V_{IN1} Input Voltage		●			3.0	V
Minimum V_{IN2} Input Voltage	$V_{IN1} = 3\text{V}$	●			2.0	V
Output DC Voltage	$\text{FB}n$ Open $\text{FB}n = 21.5\text{k}\Omega$			0.8 10		V V
Maximum Output DC Current	(Note 3)				2.5	A
Quiescent Current into V_{INn}	$\text{RUN} = 0\text{V}$ $\text{BIAS} = 5\text{V}$, $\text{SYNC} = 0\text{V}$, No Load $\text{BIAS} = 5\text{V}$, $\text{SYNC} = 3.3\text{V}$, No Load			2 60 10	4	μA μA mA
Current into BIAS	$\text{RUN} = 0\text{V}$, $\text{BIAS} = 5\text{V}$ $\text{BIAS} = 5\text{V}$, $\text{SYNC} = 3.3\text{V}$, No Load			7	1	μA mA
Line Regulation	$5\text{V} < V_{INn} < 40\text{V}$, $I_{OUTn} = 0.5\text{A}$			0.1		%
Load Regulation	12V_{INn} , $0.1\text{A} < I_{OUTn} < 2\text{A}$			0.2		%
Output RMS Ripple	$3.3V_{OUTn}$			10		mV
$\text{FB}n$ Voltage		●	792 784	800	808 816	mV mV
Current out of $\text{FB}n$	$V_{OUTn} = 1\text{V}$, $\text{FB}n = 0\text{V}$			4		μA
Minimum BIAS for Proper Operation					3.2	V
Switching Frequency	$R_T = 113\text{k}\Omega$ $R_T = 30.9\text{k}\Omega$ $R_T = 7.15\text{k}\Omega$			300 1 3		kHz MHz MHz
RUN Threshold				0.74		V
RUN Input Current	$\text{RUN} = 0\text{V}$				1	μA
$\text{PG}n$ Threshold at $\text{FB}n$	$\text{FB}n$ Rising $\text{FB}n$ Falling			740 860		mV mV
$\text{PG}n$ Output Sink Current	$\text{PG}n = 0.1\text{V}$		100			μA
CLKOUT V_{OL}				0		V
CLKOUT V_{OH}				3.3		V
SYNC Input High Threshold			1.5			V
SYNC Input Low Threshold					0.8	V
SYNC Threshold to Enable Spread Spectrum			2.8		4	V
SYNC Current	$\text{SYNC} = 6\text{V}$			65		μA
TRSS n Source Current	$\text{TRSS}n = 0\text{V}$			2		μA
TRSS n Pull-Down Resistance	Fault Condition, $\text{TRSS}n = 0.1\text{V}$			170		Ω

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

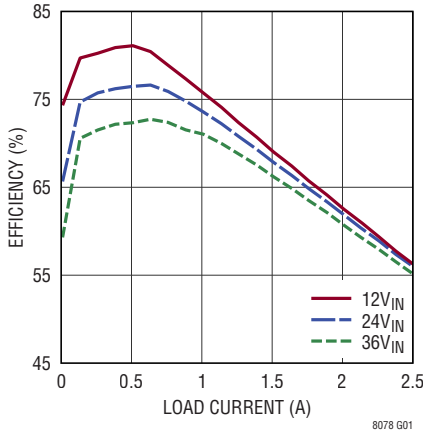
Note 2: The LTM8078E is guaranteed to meet performance specifications from 0°C to 125°C internal. Specifications over the full -40°C to 125°C internal operating temperature range are assured by design, characterization and correlation with statistical process controls.

The LTM8078I is guaranteed to meet specifications over the full -40°C to 125°C internal operating temperature range. Note that the maximum internal temperature is determined by specific operating conditions in conjunction with board layout, the rated package thermal resistance and other environmental factors.

Note 3: The maximum current out of either channel may be limited by the internal temperature of the LTM8078. See output current derating curves for different V_{IN} , V_{OUT} and T_A .

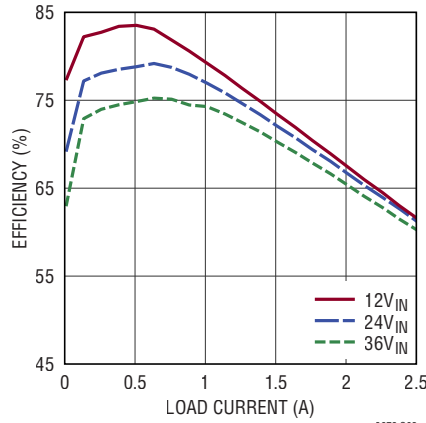
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

**Efficiency, $V_{OUT} = 0.8\text{V}$
BIAS = 5V**



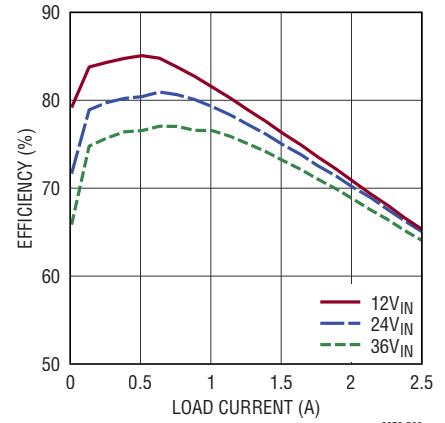
8078 G01

**Efficiency, $V_{OUT} = 1.0\text{V}$
BIAS = 5V**



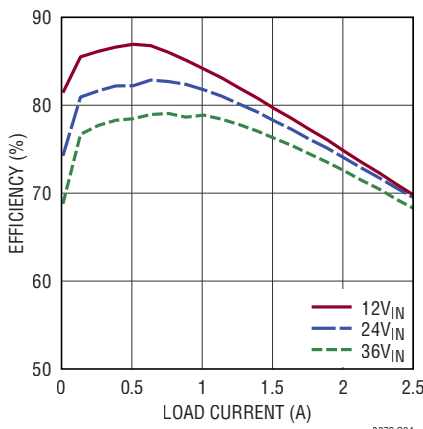
8078 G02

**Efficiency, $V_{OUT} = 1.2\text{V}$
BIAS = 5V**



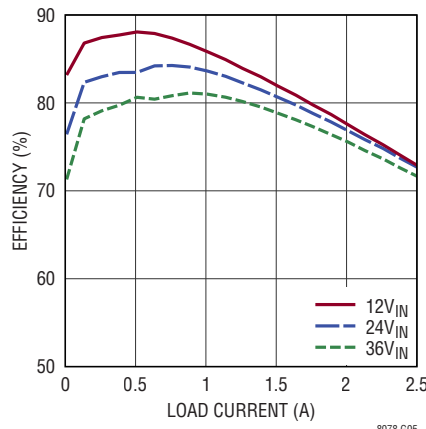
8078 G03

**Efficiency, $V_{OUT} = 1.5\text{V}$
BIAS = 5V**



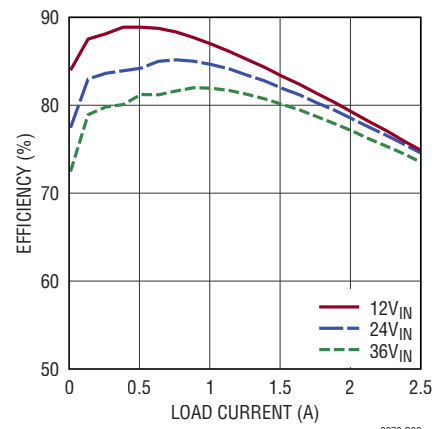
8078 G04

**Efficiency, $V_{OUT} = 1.8\text{V}$
BIAS = 5V**



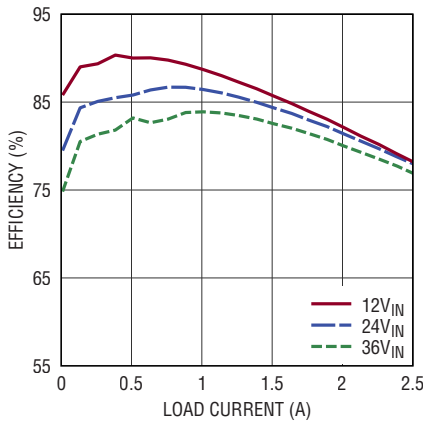
8078 G05

**Efficiency, $V_{OUT} = 2.0\text{V}$
BIAS = 5V**



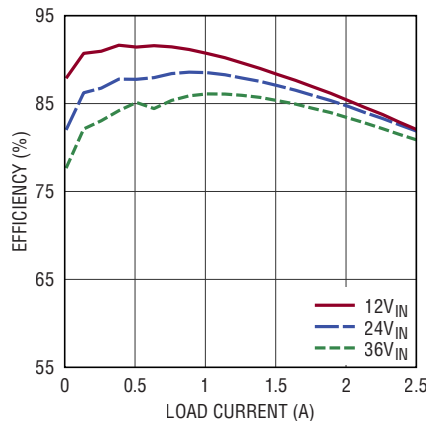
8078 G06

**Efficiency, $V_{OUT} = 2.5\text{V}$
BIAS = 5V**



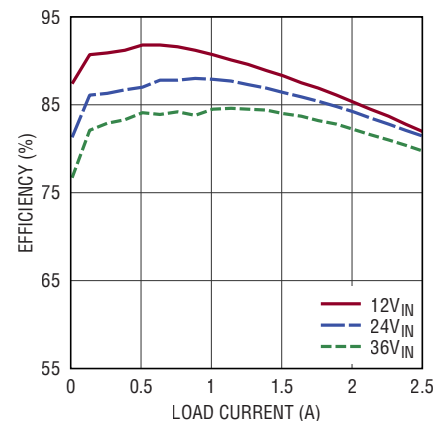
8078 G07

**Efficiency, $V_{OUT} = 3.3\text{V}$
BIAS = 5V**



8078 G08

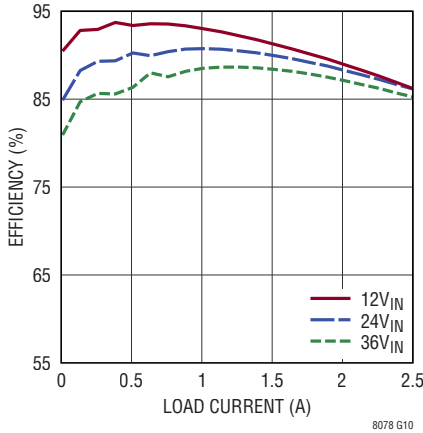
**Efficiency, $V_{OUT} = 3.3\text{V}$
BIAS = 5V, $F_{SW} = 2\text{MHz}$**



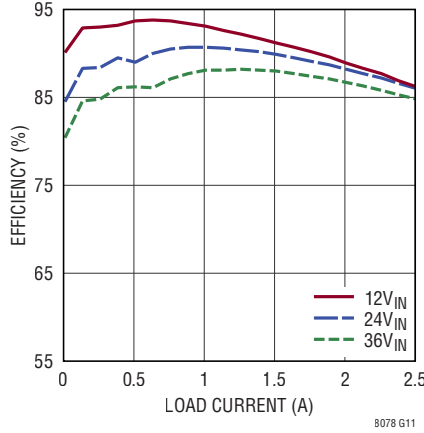
8078 G09

TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

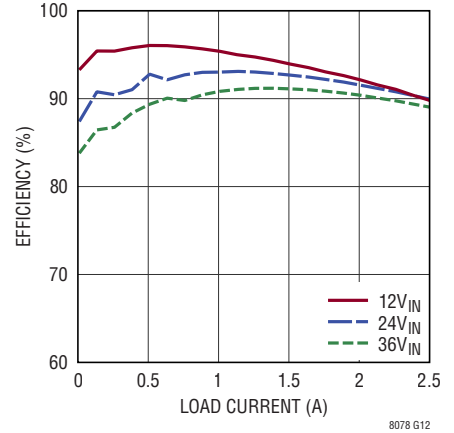
**Efficiency, $V_{OUT} = 5V$
BIAS = 5V**



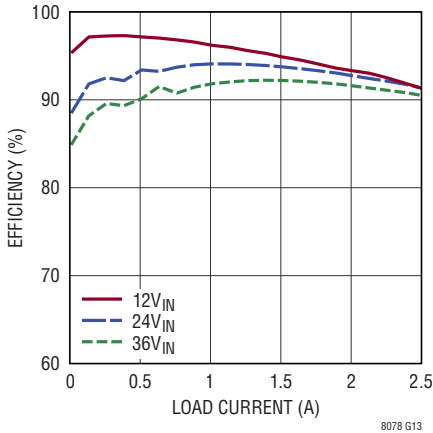
**Efficiency, $V_{OUT} = 5V$
BIAS = 5V, $F_{SW} = 2\text{MHz}$**



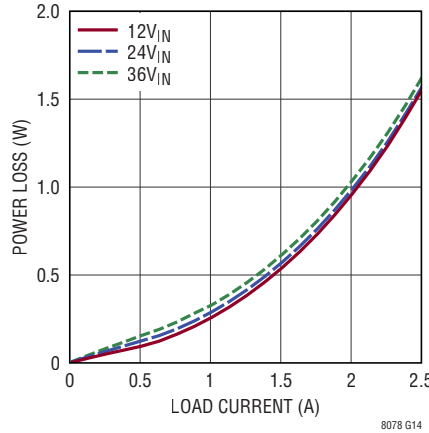
**Efficiency, $V_{OUT} = 8V$
BIAS = 5V**



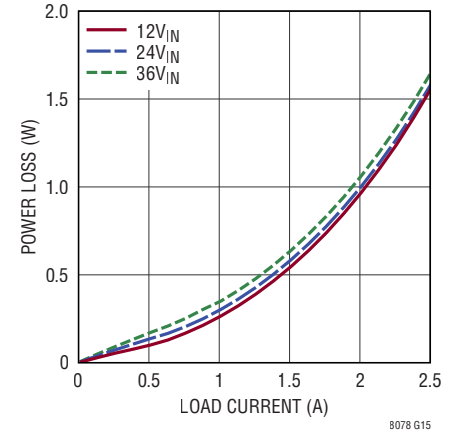
**Efficiency, $V_{OUT} = 10V$
BIAS = 5V**



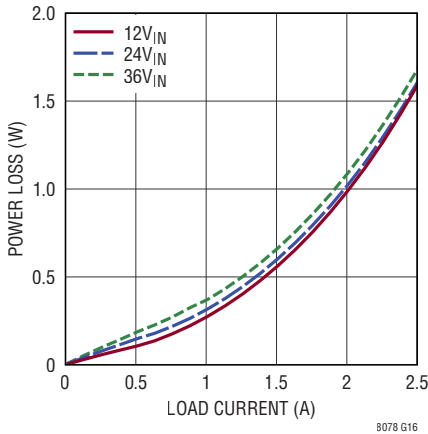
**Power Loss, $V_{OUT} = 0.8V$
BIAS = 5V, Burst Mode Operation**



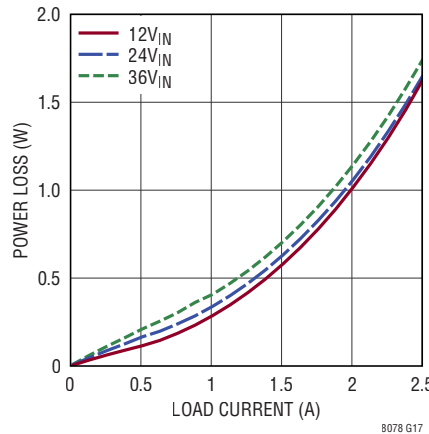
**Power Loss, $V_{OUT} = 1V$
BIAS = 5V, Burst Mode Operation**



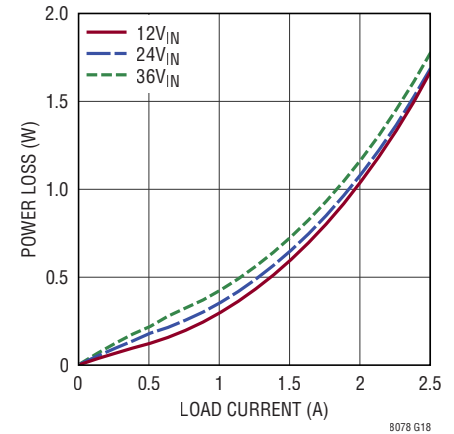
**Power Loss, $V_{OUT} = 1.2V$
BIAS = 5V, Burst Mode Operation**



**Power Loss, $V_{OUT} = 1.5V$
BIAS = 5V, Burst Mode Operation**

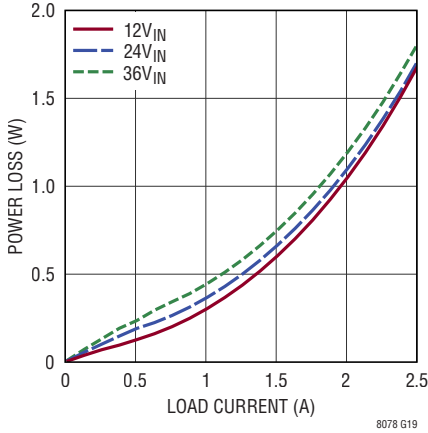


**Power Loss, $V_{OUT} = 1.8V$
BIAS = 5V, Burst Mode Operation**

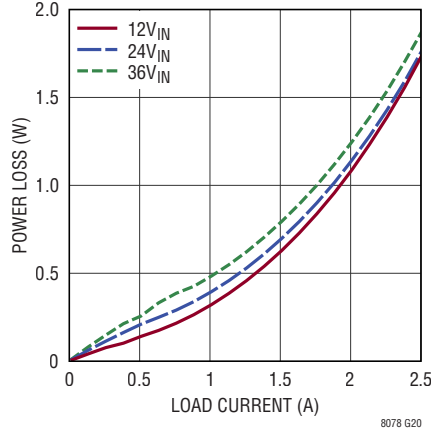


TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

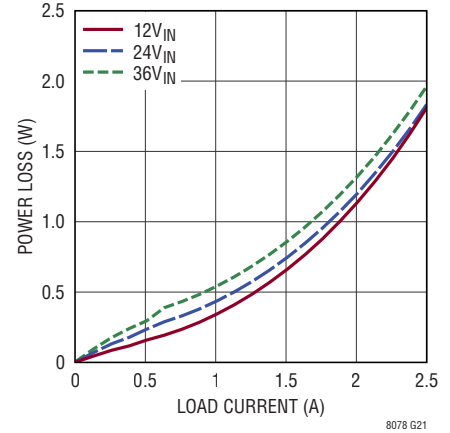
**Power Loss, $V_{OUT} = 2V$
BIAS = 5V, Burst Mode Operation**



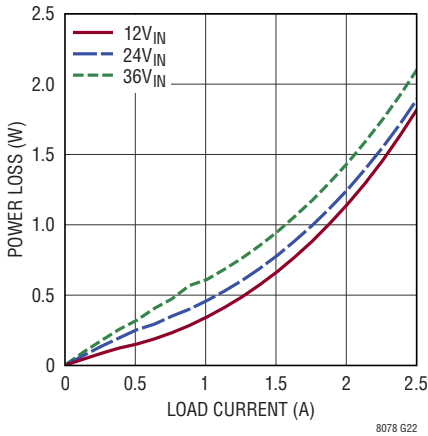
**Power Loss, $V_{OUT} = 2.5V$
BIAS = 5V, Burst Mode Operation**



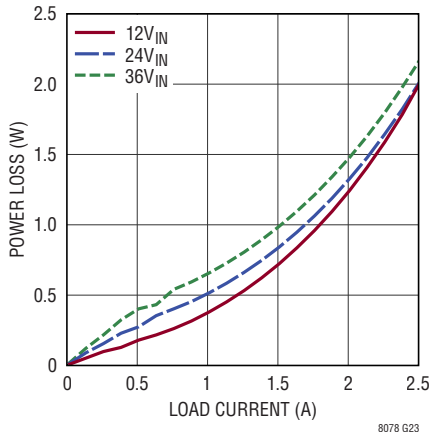
**Power Loss, $V_{OUT} = 3.3V$
BIAS = 5V, Burst Mode Operation**



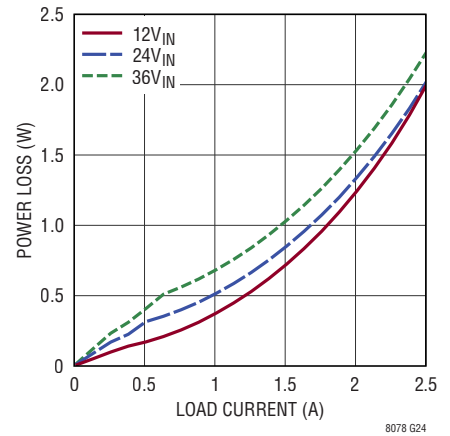
**Power Loss, $V_{OUT} = 3.3V$, 2MHz
BIAS = 5V, Burst Mode Operation**



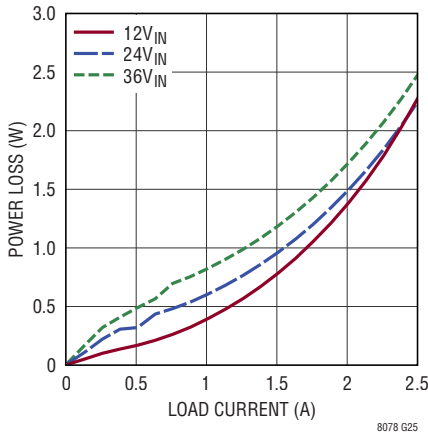
**Power Loss, $V_{OUT} = 5V$
BIAS = 5V, Burst Mode Operation**



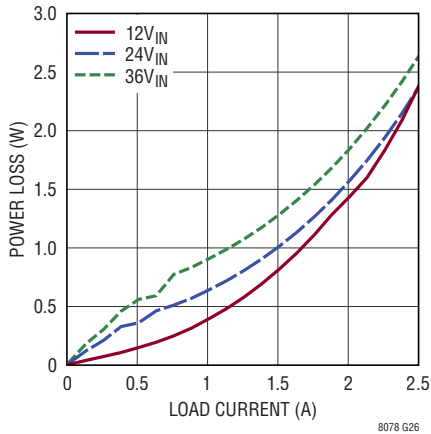
**Power Loss, $V_{OUT} = 5V$, 2MHz
BIAS = 5V, Burst Mode Operation**



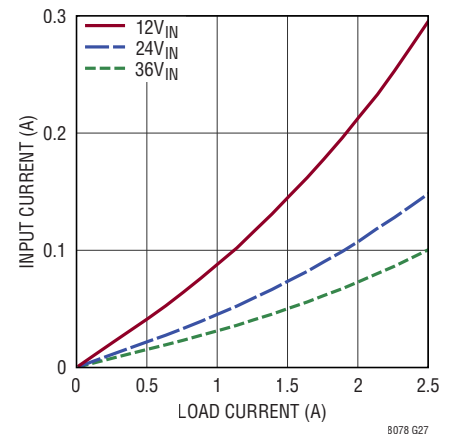
**Power Loss, $V_{OUT} = 8V$
BIAS = 5V, Burst Mode Operation**



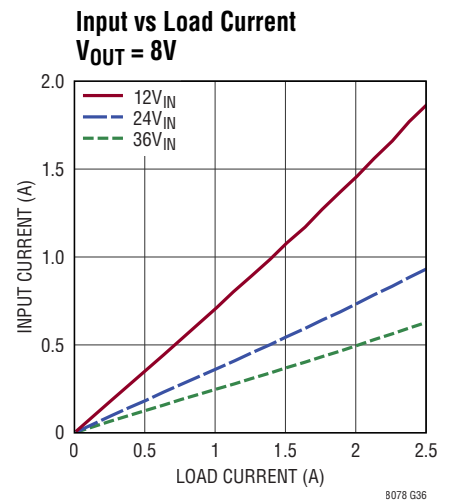
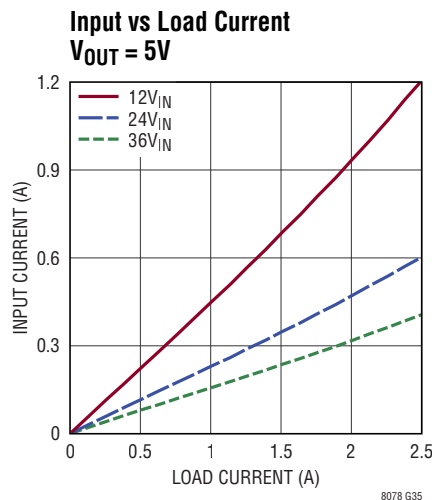
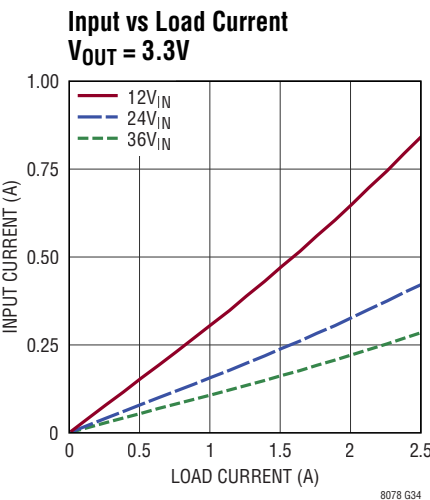
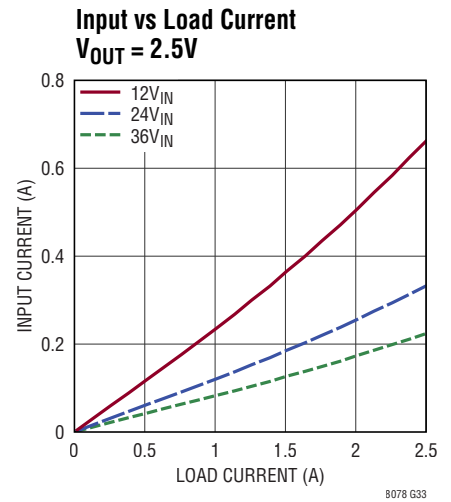
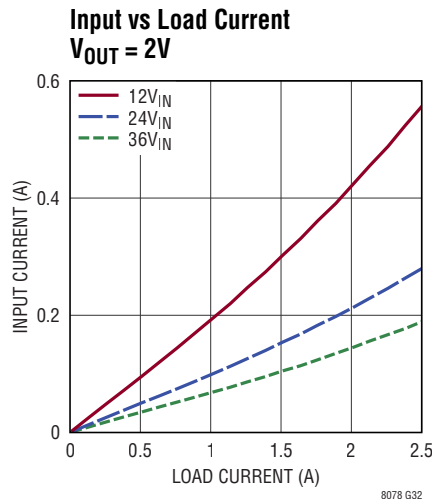
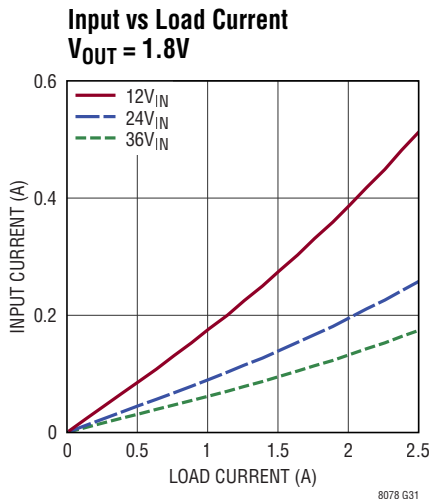
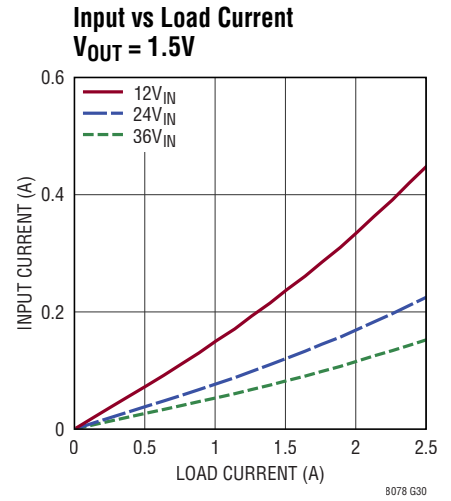
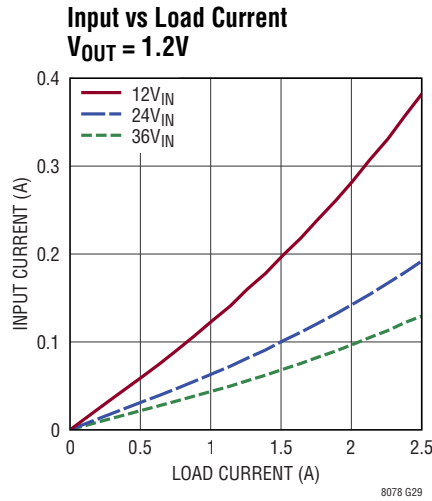
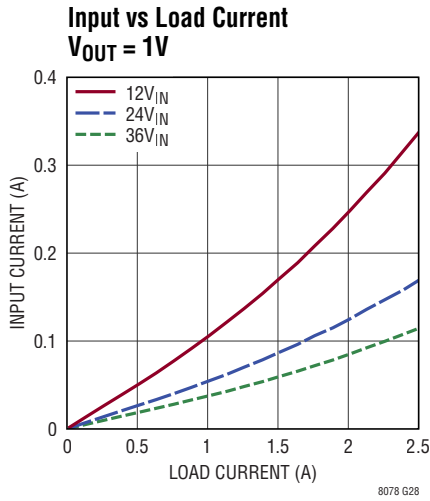
**Power Loss, $V_{OUT} = 10V$
BIAS = 5V, Burst Mode Operation**



**Input vs Load Current
 $V_{OUT} = 0.8V$**

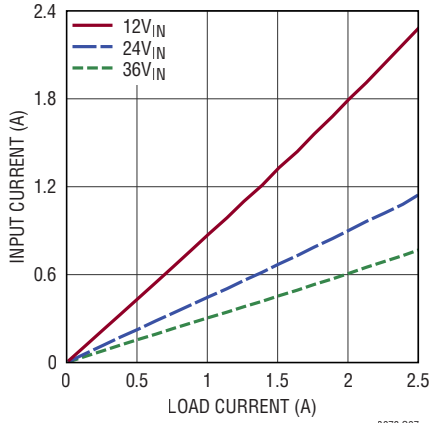


TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.



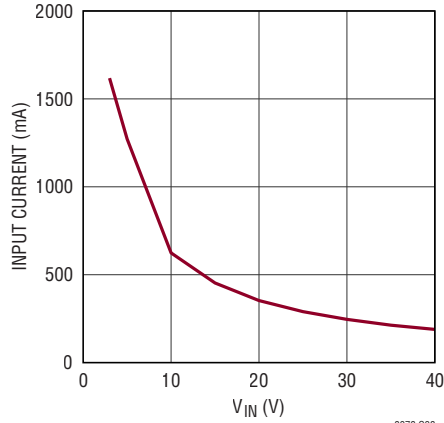
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

Input vs Load Current
 $V_{OUT} = 10V$



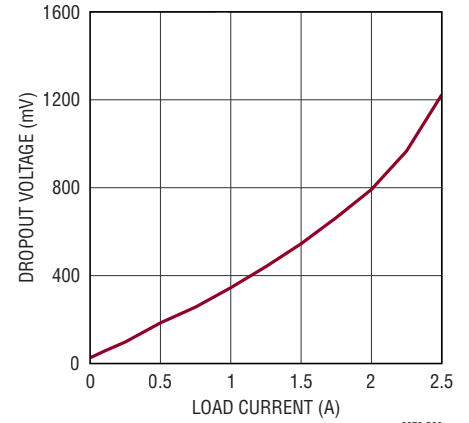
8078 G37

Input Current vs V_{IN}
 V_{OUT} Short Circuited



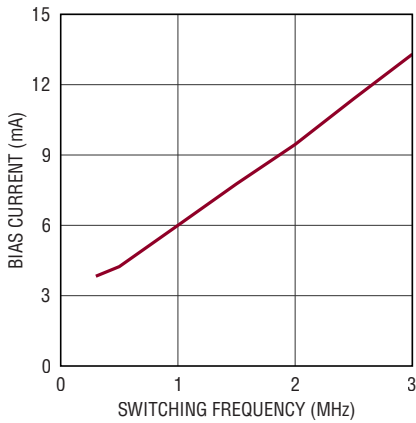
8078 G38

Dropout Voltage vs Load Current
 $V_{OUT} = 5V$, $BIAS = 5V$



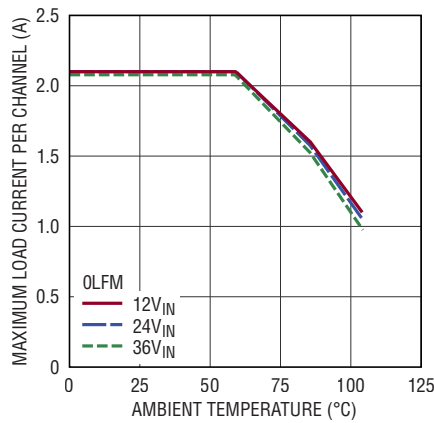
8078 G39

BIAS Current vs Frequency
 $V_{IN} = 12V$, $V_{OUT} = 3.3V$, $BIAS = 5V$
Forced Continuous Mode



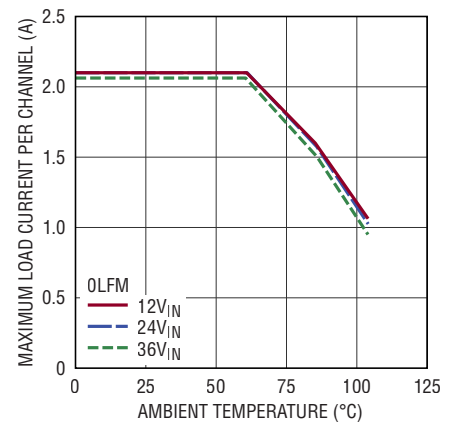
8078 G40

Derating, $V_{OUT} = 0.8V$
 $BIAS = 5V$, DC2777A Demo Board
Both Channels at Same Load



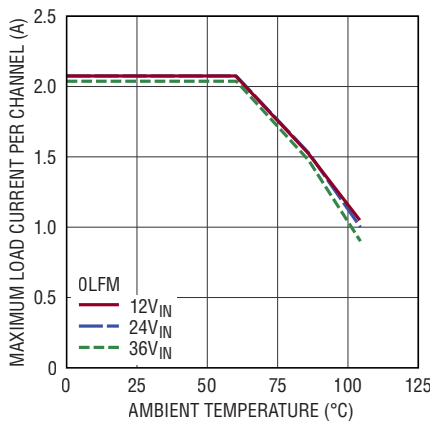
8078 G41

Derating, $V_{OUT} = 1.0V$,
 $BIAS = 5V$, DC2777A Demo Board
Both Channels at Same Load



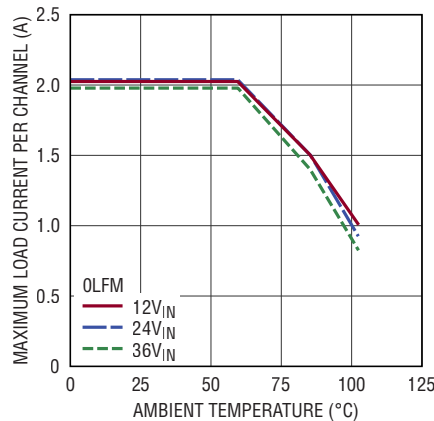
8078 G42

Derating, $V_{OUT} = 1.2V$
 $BIAS = 5V$, DC2777A Demo Board
Both Channels at Same Load



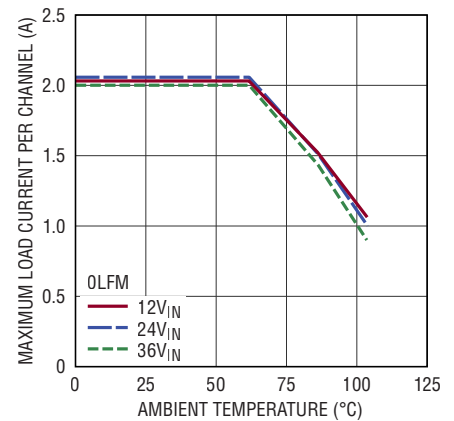
8078 G43

Derating, $V_{OUT} = 1.5V$
 $BIAS = 5V$, DC2777A Demo Board
Both Channels at Same Load



8078 G44

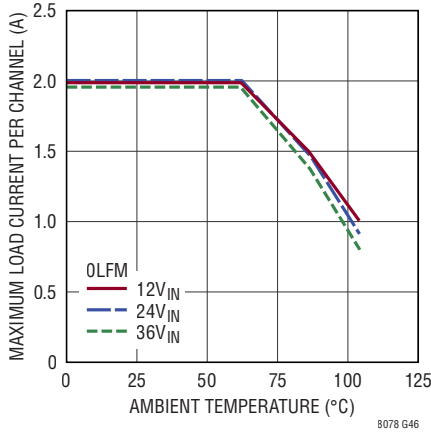
Derating, $V_{OUT} = 1.8V$,
 $BIAS = 5V$, DC2777A Demo Board
Both Channels at Same Load



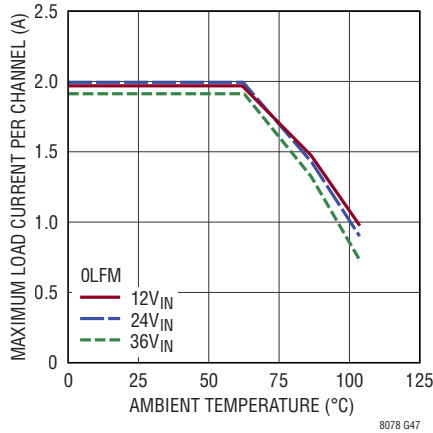
8078 G45

TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

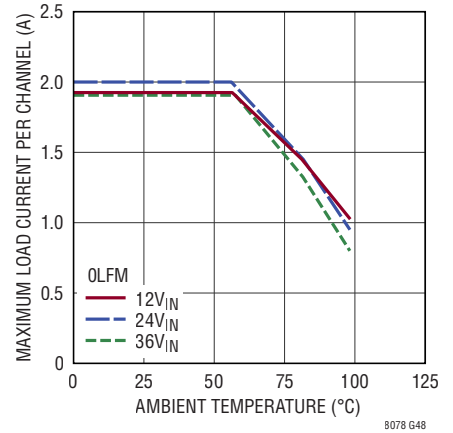
**Derating, $V_{OUT} = 2.0\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



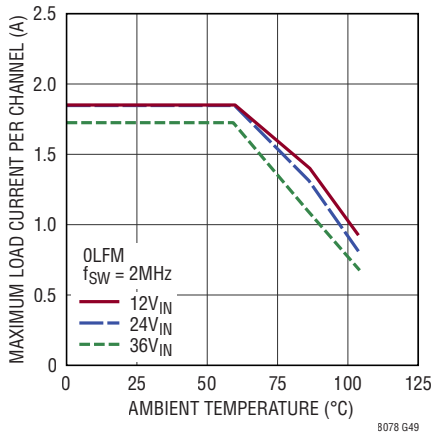
**Derating, $V_{OUT} = 2.5\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



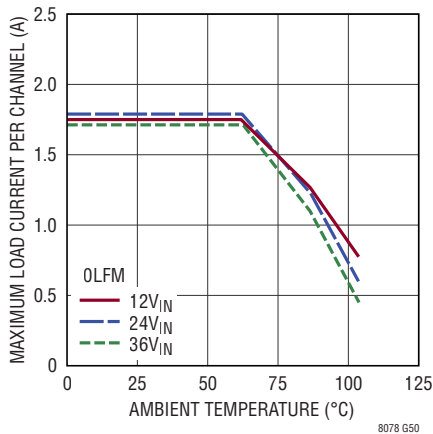
**Derating, $V_{OUT} = 3.3\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



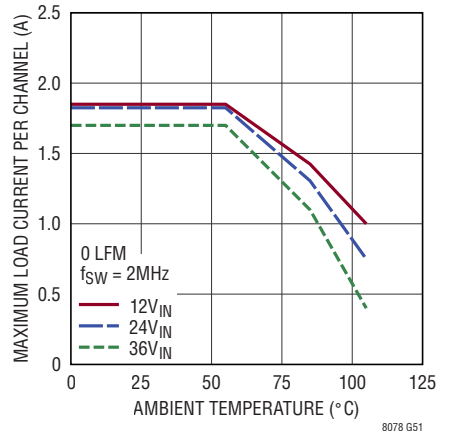
**Derating, $V_{OUT} = 3.3\text{V}$, BIAS = 5V,
DC2777A Demo Board Both Channels
at Same Load, $f_{SW} = 2\text{MHz}$**



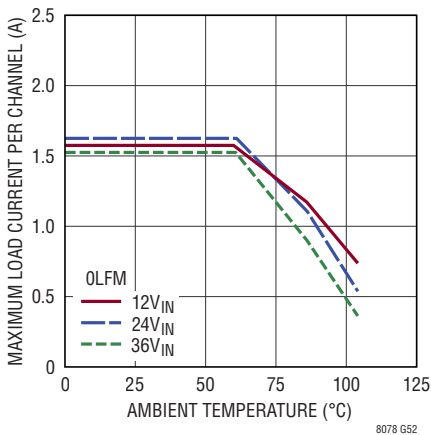
**Derating, $V_{OUT} = 5\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



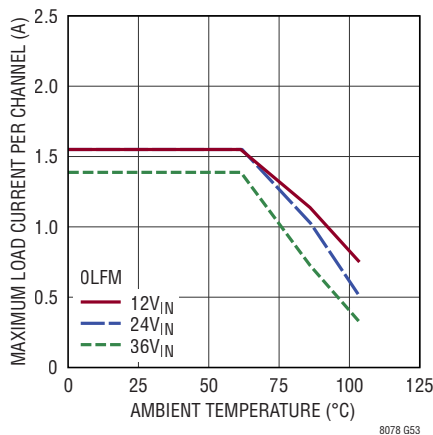
**Derating, $V_{OUT} = 5\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



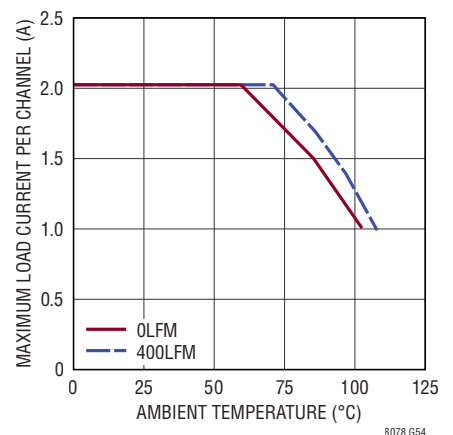
**Derating, $V_{OUT} = 8\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



**Derating, $V_{OUT} = 10\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load x**

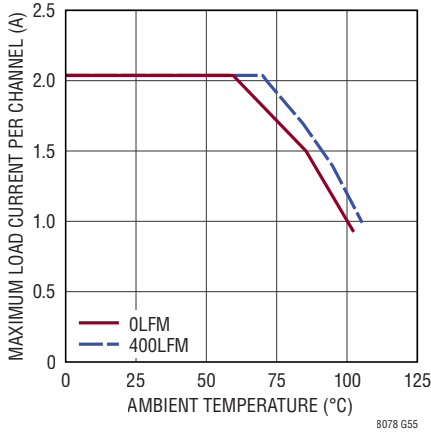


**Derating, $V_{IN} = 12\text{V}$, $V_{OUT} = 1.5\text{V}$,
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**

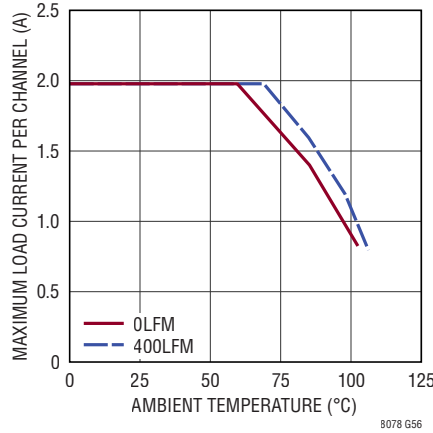


TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

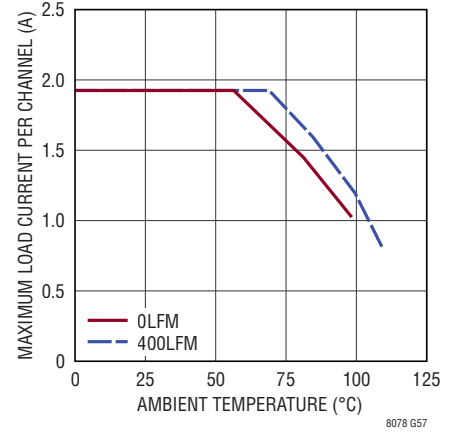
**Derating, $V_{IN} = 24\text{V}$, $V_{OUT} = 1.5\text{V}$
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



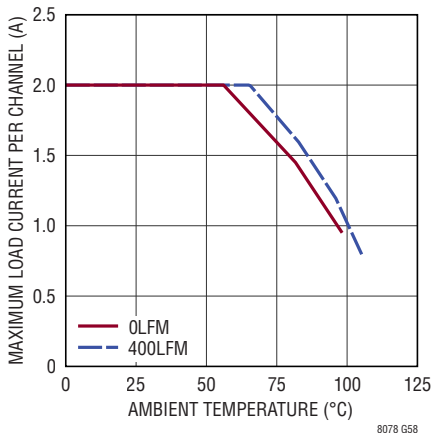
**Derating, $V_{IN} = 36\text{V}$, $V_{OUT} = 1.5\text{V}$
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



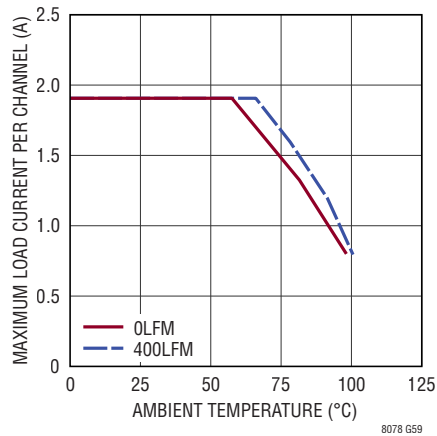
**Derating, $V_{IN} = 12\text{V}$, $V_{OUT} = 3.3\text{V}$
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



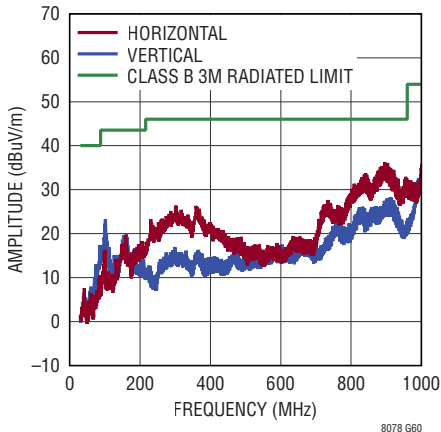
**Derating, $V_{IN} = 24\text{V}$, $V_{OUT} = 3.3\text{V}$
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



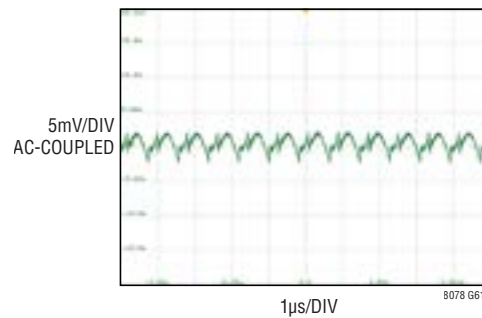
**Derating, $V_{IN} = 36\text{V}$, $V_{OUT} = 3.3\text{V}$
BIAS = 5V, DC2777A Demo Board
Both Channels at Same Load**



**CISPR22 Class B Emissions
 24V_{IN} , $f_{SW} = 1.6\text{MHz}$
 5V_{OUT1} at 1.4A, 3.3V_{OUT2} at 1.4A
Spread Spectrum On, No EMI Filter**



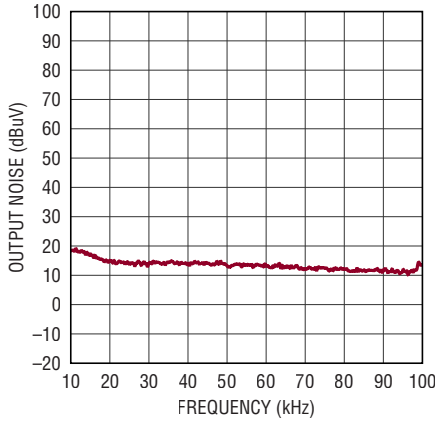
**Output Voltage Ripple DC2777A
Demo Board**



$V_{IN} = 12\text{V}$, $V_{OUT} = 3.3\text{V}$
 $I_{OUT} = 1.4\text{A}$, $f_{SW} = 1.2\text{MHz}$

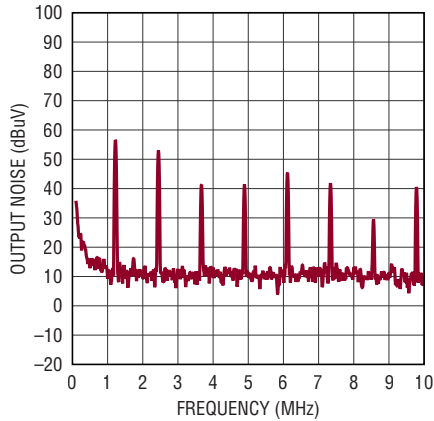
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, operating per Table 1, unless otherwise noted.

**Output Noise Spectrum
DC2777A, 100kHz Span
 $V_{IN} = 12\text{V}$, $V_{OUT} = 3.3\text{V}$
 $I_{OUT} = 1.4\text{A}$, $F_{SW} = 1.2\text{MHz}$**



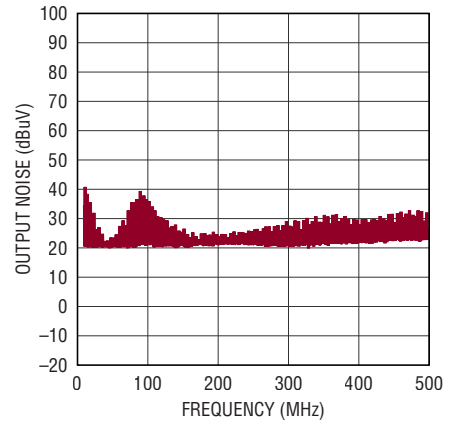
8078 G62

**Output Noise Spectrum
DC2777A, 10MHz Span
 $V_{IN} = 12\text{V}$, $V_{OUT} = 3.3\text{V}$
 $I_{OUT} = 1.4\text{A}$, $F_{SW} = 1.2\text{MHz}$**



8078 G63

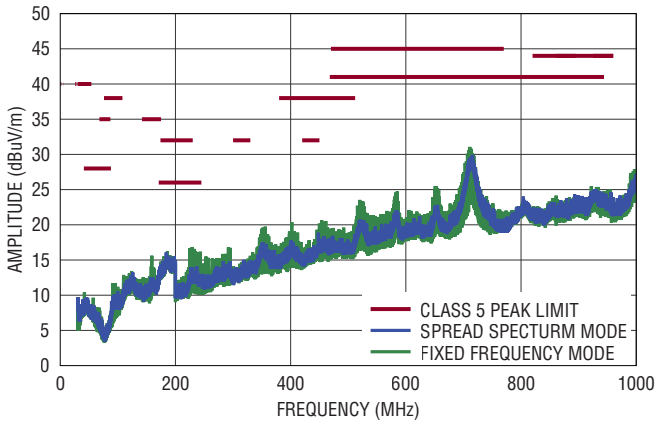
**Output Noise Spectrum
DC2777A, 500MHz Span
 $V_{IN} = 12\text{V}$, $V_{OUT} = 3.3\text{V}$
 $I_{OUT} = 1.4\text{A}$, $F_{SW} = 1.2\text{MHz}$**



8078 G64

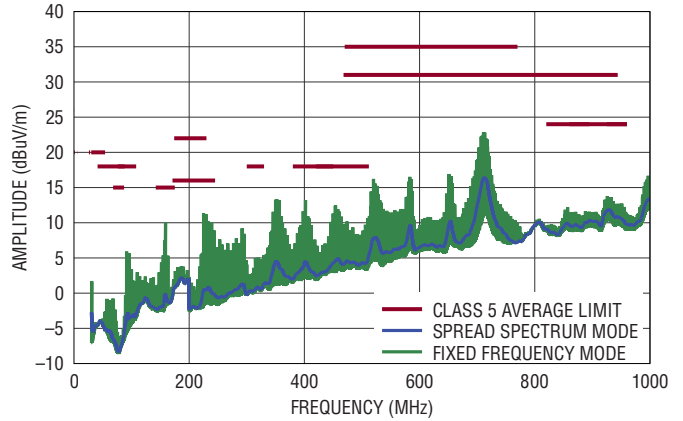
**CISPR25 Radiated Emission with Class 5 Average Limit DC2777A Demo Board, $V_{IN} = 12\text{V}$, $V_{OUT} = 3.3\text{V}$
Two Channels Paralleled, $I_{OUT} = 2.8\text{A}$, $f_{SW} = 1\text{MHz}$**

Radiated Peak



8078 G65

Radiated Average



8078 G66

PIN FUNCTIONS

V_{IN1} (Pin A3): Input Power for the Channel 1 Regulator. The V_{IN1} bank powers the internal control circuitry for both channels and is monitored by under voltage lockout circuitry. The V_{IN1} voltage must be greater than 3.0V for either channel of the LTM8078 to operate. Decouple V_{IN1} to ground with an external, low ESR capacitor. See Table 1 for recommended values.

V_{IN2} (Pin A4): Input Power for the Channel 2 Regulator. The V_{IN2} pin is monitored by under voltage lockout circuitry. The V_{IN1} voltage must be greater than 3.0V and V_{IN2} must be greater than 2V for proper V_{IN2} operation. Decouple V_{IN2} to ground with an external, low ESR capacitor. See Table 1 for recommended values.

V_{OUT1}/V_{OUT2} (Banks 1 and 2): Power Output for channels 1 and 2, Respectively. Apply the output filter capacitor and the output load between these pins and GND pins.

GND (Bank 3, Pin A7): Tie these GND pins to a local ground plane below the LTM8078 and the circuit components. In most applications, the bulk of the heat flow out of the LTM8078 is through these pads, so the printed circuit design has a large impact on the thermal performance of the part. See the PCB Layout and Thermal Considerations sections for more details. Return the feedback divider (R_{FB}) to this net.

BIAS (Pin E7): The internal regulator will draw current from BIAS instead of V_{IN1} when BIAS is tied to a voltage higher than 3.2V. For output voltages of 3.3V and above this pin should be tied to V_{OUT}. If this pin is tied to a supply other than V_{OUT} connect a local bypass capacitor to this pin.

CLKOUT (Pin D1): Synchronization Output. When SYNC > 2.8V, the CLKOUT pin provides a waveform about 90 degrees out-of-phase with Channel 1. This allows synchronization with other regulators with up to four phases. When an external clock is applied to the SYNC pin, the CLKOUT pin will output a waveform with about the same

phase, duty cycle, and frequency as the SYNC waveform. In Burst Mode operation, the CLKOUT pin will be internally grounded. Float this pin if the CLKOUT function is not used. Do not drive this pin.

FB1/FB2 (Pins D7, C7): The LTM8078 regulates the FB_n pins to 800mV. Connect the feedback resistor to this pin to set the output voltage.

PG1/PG2 (Pins B1, A2): The PG_n pins are the open-drain outputs of an internal comparator. PG_n remains low until the FB_n pin is within ±7.5% of the final regulation voltage, and there are no fault conditions. PG_n is pulled low during V_{IN1} UVLO, V_{IN2} UVLO, thermal shutdown, or when the RUN pin is low.

RT (Pin B7): Connect a resistor between RT and ground to set the switching frequency of both channels. Do not drive this pin.

RUN (Pin A5): The LTM8078 is shut down when this pin is low and active when this pin is high. Tie to V_{IN_n} if shutdown feature is not used. An external resistor divider from V_{IN_n} can be used to program a V_{IN_n} threshold below which the corresponding channel of the LTM8078 will shut down. Do not float this pin.

OM (Pin C6): Output Mode. Tie this pin to the adjacent OMC pin when the two LTM8078 outputs are regulating at different voltages. Float this pin when the two LTM8078 outputs are in parallel.

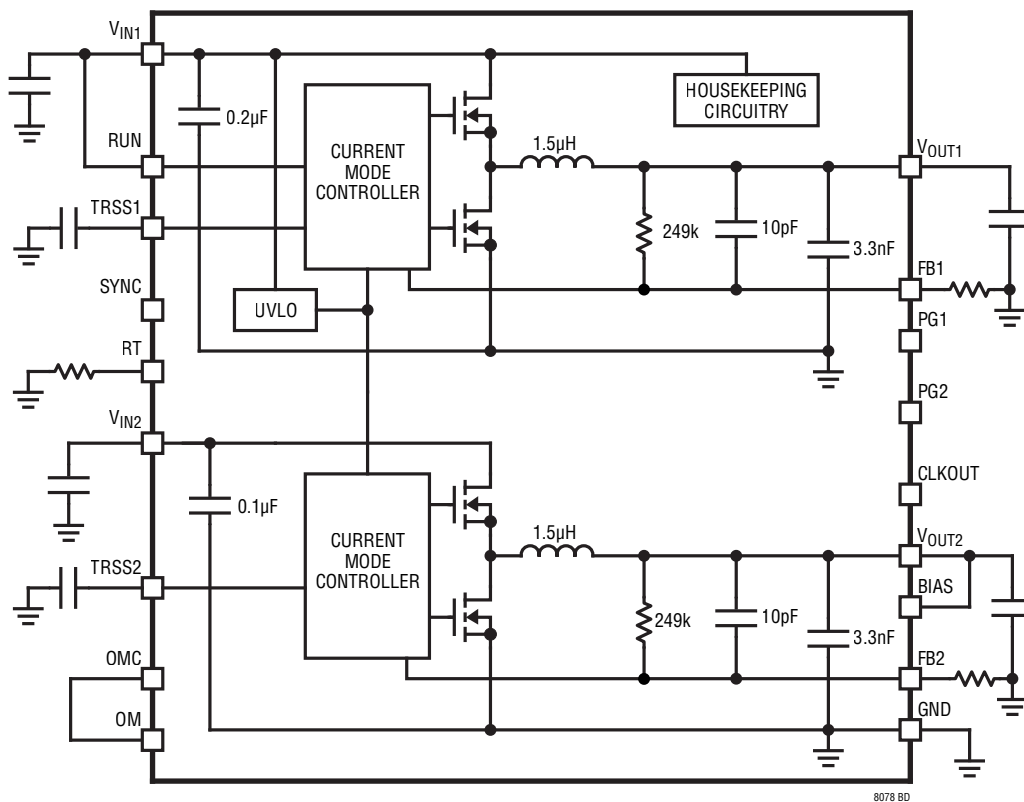
OMC (Pin D6): Output Mode Control. Float this pin when the two outputs of the LTM8078 are load sharing. Connect this pin to the OMC pin of other LTM8078s when multiple LTM8078s are load sharing. When not load sharing, tie this pin to the adjacent OM pin. That is, when the V_{OUT1} and V_{OUT2} are independent voltages, connect OM to OMC. If V_{OUT1} and V_{OUT2} are independent and OM and OMC are not connected together, the LTM8078 will not regulate properly.

PIN FUNCTIONS

TRSS1/TRSS2 (Pin B6, A6): Output Tracking and Soft-Start Pins. These pins allow user control of the output voltage ramp rate during startup. A TRSS n voltage below 0.8V forces the LTM8078 to regulate the FB n pin to equal the TRSS n pin voltage. When TRSS n is above 0.8V, the tracking function is disabled and the internal reference resumes control of the error amplifier. An internal 2 μ A pull-up current on this pin allows a capacitor to program output voltage slew rate. This pin is pulled to ground during shutdown and fault conditions; use a series resistor if driving from a low impedance output. This pin may be left floating if the soft-start feature is not being used.

SYNC (Pin C1): External Clock Synchronization Input. Ground this pin for low ripple Burst Mode operation at low output loads; this will also disable the CLKOUT function. Apply a DC voltage between 2.8V and 4V for spread spectrum modulation. Float the SYNC pin for forced continuous operation without spread spectrum modulation. Apply a clock source to the SYNC pin for synchronization to an external frequency. The LTM8078 will be in forced continuous mode when an external frequency is applied.

BLOCK DIAGRAM



OPERATION

The LTM8078 is a dual standalone non-isolated step-down switching DC/DC power supply that can deliver a peak current of up to 2.5A per channel. The continuous current is determined by the internal operating temperature. It provides a precisely regulated output voltage programmable via one external resistor from 0.8V to 10V. The input voltage range for channel 1 is 3V to 40V, while the input voltage range for channel 2 is 2V to 40V. V_{IN1} must be 3V or above for either channel to operate.

Given that the LTM8078 is a step-down converter, make sure that the input voltage is high enough to support the desired output voltage and load current. See simplified Block Diagram.

The LTM8078 contains two current mode controllers, power switching elements, power inductors and a modest amount of input and output capacitance. The LTM8078 is a fixed frequency PWM regulator. The switching frequency is set by simply connecting the appropriate resistor value from the RT pin to GND.

An internal regulator provides power to the control circuitry. This bias regulator normally draws power from the V_{IN1} pin, but if the BIAS pin is connected to an external voltage higher than 3.2V, bias power is drawn from the external source (typically the regulated output voltage). This improves efficiency. Tie BIAS to GND if it is not used.

To enhance efficiency, the LTM8078 automatically switches to Burst Mode operation in light or no load situations. Between bursts, all circuitry associated with controlling the output switch is shut down reducing the input supply current to just a few μ A.

The TRSS n node acts as an auxiliary input to the error amplifier. The voltage at FB servos to the TRSS voltage until TRSS goes above 0.8V. Soft-start is implemented by generating a voltage ramp at the TRSS pin using an external capacitor which is charged by an internal constant current. Alternatively, driving the TRSS pin with a signal source or resistive network provides a tracking function. Do not drive the TRSS pin with a low impedance voltage source. See the Applications Information section for more details.

The LTM8078 contains a power good comparator which trips when the FB n pin is at about 92% to 108% of its regulated value. The PG n output is an open-drain transistor that is off when the output is in regulation, allowing an external resistor to pull the PG n pin high. The PG1 signal is valid when V_{IN1} is above 3V. Similarly, the PG2 signal is valid when V_{IN2} is above 2V.

The LTM8078 is equipped with a thermal shutdown that inhibits power switching at high junction temperatures. The activation threshold of this function is above the maximum temperature rating to avoid interfering with normal operation, so prolonged or repetitive operation under a condition in which the thermal shutdown activates may damage or impair the reliability of the device.

APPLICATIONS INFORMATION

For most applications, the design process is straightforward, summarized as follows:

1. Look at Table 1 and find the row that has the desired input range and output voltage.
2. Apply the recommended C_{IN} , C_{OUT} , R_{FB} and R_T values.
3. Connect BIAS as indicated.

When using the LTM8078 with two different output voltages, the higher frequency recommended by Table 1 will usually result in the best operation. While these component combinations have been tested for proper operation, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions. Bear in mind that the maximum output current is limited by junction temperature, the relationship between the input and output voltage magnitude and other factors. Please refer to the graphs in the Typical Performance Characteristics section for guidance.

The maximum frequency (and attendant R_T value) at which the LTM8078 should be allowed to switch is given in Table 1 in the Maximum f_{SW} column, while the recommended frequency (and R_T value) for optimal efficiency over the given input condition is given in the f_{SW} column. There are additional conditions that must be satisfied if the synchronization function is used. Please refer to the Synchronization section for details.

Capacitor Selection Considerations

The C_{IN} and C_{OUT} capacitor values in Table 1 are the minimum recommended values for the associated operating conditions. Applying capacitor values below those indicated in Table 1 is not recommended and may result in undesirable operation. Using larger values is generally acceptable, and can yield improved dynamic response. Again, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

Ceramic capacitors are small, robust and have very low ESR. However, not all ceramic capacitors are suitable. X5R and X7R types are stable over temperature and applied voltage and give dependable service. Other types, including Y5V and Z5U have very large temperature and voltage coefficients of capacitance. In an application circuit they may have only a small fraction of their nominal capacitance resulting in much higher output voltage ripple than expected.

Ceramic capacitors are also piezoelectric. In Burst Mode operation, the LTM8078's switching frequency depends on the load current, and can excite a ceramic capacitor at audio frequencies, generating audible noise. Since the LTM8078 operates at a lower current limit during Burst Mode operation, the noise is typically very quiet to the casual ear.

Table 1. Recommended Component Values and Configuration ($T_A = 25^\circ\text{C}$)

V_{IN} (NOTE 1)	V_{OUT}	R_{FB} (k Ω)	C_{IN} (NOTE 2)	C_{OUT}	BIAS	f_{SW} (kHz)	R_T (k Ω)	MAX f_{SW} (MHz)	MIN R_T (k Ω)
3V to 40V	0.8V	Open	1 μ F 50V X5R 0805	2 \times 100 μ F 4V X5R 0805	3.2V to 10V	500	68.1	1.2	24.9
3V to 40V	1V	1000	1 μ F 50V X5R 0805	2 \times 100 μ F 4V X5R 0805	3.2V to 10V	600	54.9	1.4	21.0
3V to 40V	1.2V	499	1 μ F 50V X5R 0805	2 \times 100 μ F 4V X5R 0805	3.2V to 10V	700	46.4	1.4	21.0
3.2V to 40V	1.5V	287	1 μ F 50V X5R 0805	100 μ F 4V X5R 0805	3.2V to 10V	900	34.8	1.4	21.0
3.2V to 40V	1.8V	200	1 μ F 50V X5R 0805	100 μ F 4V X5R 0805	3.2V to 10V	900	34.8	1.8	15.0
3.6V to 40V	2V	165	1 μ F 50V X5R 0603	100 μ F 4V X5R 0805	3.2V to 10V	1000	30.9	1.8	15.0
4.2V to 40V	2.5V	118	1 μ F 50V X5R 0603	47 μ F 4V X5R 0805	3.2V to 10V	1100	28.0	2	13.3
5V to 40V	3.3V	78.7	1 μ F 50V X5R 0603	22 μ F 6.3V X5R 0805	3.2V to 10V	1200	24.9	2.8	8.06
7V to 40V	5V	47.5	1 μ F 50V X5R 0603	10 μ F 6.3V X7R 0603	3.2V to 10V	1400	21.0	3	7.15
10.5V to 40V	8V	27.4	1 μ F 50V X5R 0805	10 μ F 10V X5R 0805	3.2V to 10V	2000	13.3	3	7.15
12V to 40V	10V	21.5	1 μ F 50V X5R 0805	10 μ F 16V X5R 1206	3.2V to 10V	2200	11.5	3	7.15

Note 1: The LTM8078 may be capable of the operating at lower input voltages but may skip switching cycles.

Note 2: A bulk input capacitor is required.

APPLICATIONS INFORMATION

If this audible noise is unacceptable, use a high performance electrolytic capacitor at the output. It may also be a parallel combination of a ceramic capacitor and a low cost electrolytic capacitor.

A final precaution regarding ceramic capacitors concerns the maximum input voltage rating of the LTM8078. A ceramic input capacitor combined with trace or cable inductance forms a high-Q (underdamped) tank circuit. If the LTM8078 circuit is plugged into a live supply, the input voltage can ring to twice its nominal value, possibly exceeding the device's rating. This situation is easily avoided; see the Hot-Plugging Safely section.

Frequency Selection

The LTM8078 uses a constant frequency PWM architecture that can be programmed to switch from 300kHz to 3MHz by using a resistor tied from the RT pin to ground. Table 2 provides a list of R_T resistor values and their resultant frequencies. The resistors in the table are standard 1% E96 values.

Table 2. Switching Frequency vs R_T Value

f_{sw} (MHz)	R_T (k Ω)
0.3	113
0.4	86.6
0.5	68.1
0.6	54.9
0.7	46.4
0.8	40.2
0.9	34.8
1.0	30.9
1.2	24.9
1.4	21.0
1.6	17.8
1.8	15.0
2.0	13.3
2.2	11.5
2.4	10.2
2.6	9.09
2.8	8.06
3.0	7.15

Operating Frequency Trade-Offs

It is recommended that the user apply the optimal R_T value given in Table 1 for the input and output operating condition. When using the LTM8078 with two different output voltages, the higher frequency recommended by Table 1 will usually result in the best operation. System level or other considerations, however, may necessitate another operating frequency. While the LTM8078 is flexible enough to accommodate a wide range of operating frequencies, a haphazardly chosen one may result in undesirable operation under certain operating or fault conditions. A frequency that is too high can reduce efficiency, generate excessive heat or even damage the LTM8078 if the output is overloaded or short-circuited. A frequency that is too low can result in a final design that has too much output ripple or too large of an output capacitor.

BIAS Pin Considerations

The BIAS pin is used to provide drive power for the internal power switching stage and operate other internal circuitry. For proper operation, it must be powered by at least 3.2V. If the output voltage is programmed to 3.2V or higher, BIAS may be simply tied to V_{OUT} . If V_{OUT} is less than 3.2V, BIAS can be tied to V_{IN} or some other voltage source. If the BIAS pin voltage is too high, the efficiency of the LTM8078 may suffer. The optimum BIAS voltage is dependent upon many factors, such as load current, input voltage, output voltage and switching frequency. In all cases, ensure that the maximum voltage at the BIAS pin is less than 10V. If BIAS power is applied from a remote or noisy voltage source, it may be necessary to apply a decoupling capacitor locally to the pin. A 1 μ F ceramic capacitor works well. The BIAS pin may also be tied to GND at the cost of a small degradation in efficiency.

Maximum Load

The maximum practical continuous load that the LTM8078 can drive per channel, while rated at 1.4A, actually depends upon both the internal current limit and the internal temperature. The internal current limit is designed to prevent damage to the LTM8078 in the case of overload or short-circuit. The internal temperature of the LTM8078 depends upon operating conditions such as the ambient

APPLICATIONS INFORMATION

temperature, the power delivered, and the heat sinking capability of the system. For example, if a single LTM8078 is configured to regulate at 1V, and channel 2 is turned off, channel 1 may continuously deliver 2.5A from 12V_{IN} if the ambient temperature is controlled to less than 60°C. This is quite a bit higher than the 1.4A continuous rating. Please see graphs in the Typical Performance Characteristics section. Similarly, if both channels of the LTM8078 are delivering 8V_{OUT} and the ambient temperature is 100°C, each channel will deliver at most 0.6A from 24V_{IN}, which is less than the 1.4A continuous rating.

Load Sharing

The two LTM8078 channels may be paralleled to produce higher currents. To do this on two or more LTM8078, tie the V_{IN}, V_{OUT}, FB and OMC pins of all the paralleled channels/modules together (see Figure 7). If only the two channels of a LTM8078 are paralleled, leave OMC and OM floating. To ensure that paralleled channels start up together, the TRSS pins may be tied together, as well. If it is inconvenient to tie the TRSS pins together, make sure that the same value soft-start capacitors are used for each μ Module regulator. When load sharing among n units and using a single R_{FB} resistor, the value of the resistor is:

$$R_{FB} = \frac{199.2}{n(V_{OUT} - 0.8)}, \text{ where } R_{FB} \text{ is in } k\Omega$$

When the LTM8078 outputs regulate independently, tie OM to OMC. Examples of load sharing applications are given in Figure 4 through Figure 6.

Burst Mode Operation

To enhance efficiency at light loads, the LTM8078 automatically switches to Burst Mode operation which keeps the output capacitor charged to the proper voltage while minimizing the input quiescent current. During Burst Mode operation, the LTM8078 delivers single cycle bursts of current to the output capacitor followed by sleep periods where most of the internal circuitry is powered off and energy is delivered to the load by the output capacitor. During the sleep time, V_{IN} and BIAS quiescent currents

are greatly reduced, so, as the load current decreases towards a no load condition, the percentage of time that the LTM8078 operates in sleep mode increases and the average input current is greatly reduced, resulting in higher light load efficiency.

Burst Mode operation is enabled by tying SYNC to GND.

Minimum Input Voltage

The LTM8078 is a step-down converter, so a minimum amount of headroom is required to keep the output in regulation. Keep the input above 3V to ensure proper operation. Voltage transients or ripple valleys that cause the input to fall below 3V may turn off the LTM8078.

V_{IN1} must be above 3V for either channel to operate. If V_{IN1} is above 3V, channel 2 will operate as long as V_{IN2} is above 2V.

Output Voltage Tracking and Soft-Start

The LTM8078 allows the user to adjust its output voltage ramp rate by means of the TRSS pin. An internal 2 μ A pulls up the TRSS n pin to about 2.4V. Putting an external capacitor on TRSS n enables soft starting the output to reduce current surges on the input supply. During the soft-start ramp the output voltage will proportionally track the TRSS n pin voltage. For output tracking applications, TRSS n can be externally driven by another voltage source. From 0V to 0.8V, the TRSS n voltage will override the internal 0.8V reference input to the error amplifier, thus regulating the FB n pin voltage to that of the TRSS n pin. When TRSS n is above 0.8V, tracking is disabled and the feedback voltage will regulate to the internal reference voltage. The TRSS n pin may be left floating if the function is not needed.

An active pull-down circuit is connected to the TRSS n pin which will discharge the external soft-start capacitor in the case of fault conditions and restart the ramp when the faults are cleared. Fault conditions that clear the soft-start capacitor are the RUN n pin transitioning low, V_{IN n} voltage falling too low, or thermal shutdown.

APPLICATIONS INFORMATION

Pre-Biased Output

As discussed in the Output Voltage Tracking and Soft-Start section, the LTM8078 regulates the output to the FB voltage determined by the TRSS n pin whenever TRSS n is less than 0.8V. If the LTM8078 output is higher than the target output voltage, and SYNC is not held below 0.8V, the LTM8078 will attempt to regulate the output to the target voltage by returning a small amount of energy back to the input supply. If there is nothing loading the input supply, its voltage may rise. Take care that it does not rise so high that the input voltage exceeds the absolute maximum rating of the LTM8078. If SYNC is grounded, the LTM8078 will not return current to the input.

Synchronization

To select low ripple Burst Mode operation, tie the SYNC pin below about 0.8V (this can be ground or a logic low output). To synchronize the LTM8078 oscillator to an external frequency, connect a square wave (with about 20% to 80% duty cycle) to the SYNC pin. The square wave amplitude should have valleys that are below 0.8V and peaks above 1.5V.

The LTM8078 may be synchronized over a 300kHz to 3MHz range. The LTM8078 will not enter Burst Mode operation at light output loads while synchronized to an external clock. The R_T resistor should be chosen to set the switching frequency equal to or below the lowest synchronization input. For example, if the synchronization signal will be 500kHz and higher, the R_T should be selected for 500kHz or lower.

The LTM8078 features spread spectrum operation to further reduce EMI/EMC emissions. To enable spread spectrum operation, apply between 2.8V and 4V to the SYNC pin. In this mode, triangular frequency modulation is used to vary the switching frequency between the value programmed by R_T to about 20% higher than that value. The

modulation frequency is about 5kHz. For example, when the LTM8078 is programmed to 2MHz, the frequency will vary from 2MHz to 2.4MHz at a 5kHz rate. When spread spectrum operation is selected, Burst Mode operation is disabled, and the part may run in discontinuous mode.

Shorted Input Protection

Care needs to be taken in systems where the output is held high when the input to the LTM8078 is absent. This may occur in battery charging applications or in battery backup systems where a battery or some other supply is diode OR'ed with the LTM8078's output. If the V_{IN} pin is allowed to float and the RUN pin is held high (either by a logic signal or because it is tied to V_{IN}), then the LTM8078's internal circuitry pulls its quiescent current through its internal power switch. This is fine if your system can tolerate a few milliamps in this state. If you ground the RUN pin, the internal current drops to essentially zero. However, if the V_{IN} pin is grounded while the output is held high, parasitic diodes inside the LTM8078 can pull large currents from the output through the V_{IN} pin. Figure 1 shows a circuit that runs only when the input voltage is present and that protects against a shorted or reversed input.

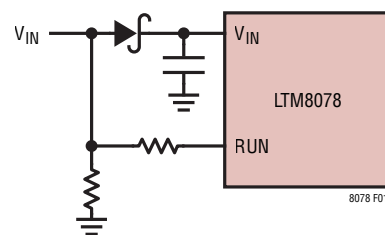


Figure 1. The Input Diode Prevents a Shorted Input from Discharging a Backup Battery Tied to the Output. It Also Protects the Circuit from a Reversed Input. The LTM8078 Runs Only When the Input Is Present

APPLICATIONS INFORMATION

PCB Layout

Most of the headaches associated with PCB layout have been alleviated or even eliminated by the high level of integration of the LTM8078. The LTM8078 is nevertheless a switching power supply, and care must be taken to minimize EMI and ensure proper operation. Even with the high level of integration, you may fail to achieve specified operation with a haphazard or poor layout. See Figure 2 for a suggested layout. Ensure that the grounding and heat sinking are acceptable.

A few rules to keep in mind are:

1. Place the R_{FB} and R_T resistors as close as possible to their respective pins.
2. Place the C_{IN} capacitor as close as possible to the V_{IN} and GND connection of the LTM8078.
3. Place the C_{OUT} capacitor as close as possible to the V_{OUT} and GND connection of the LTM8078.
4. Place the C_{IN} and C_{OUT} capacitors such that their ground current flow directly adjacent to or underneath the LTM8078.
5. Connect all of the GND connections to as large a copper pour or plane area as possible on the top layer. Avoid breaking the ground connection between the external components and the LTM8078.
6. Use vias to connect the GND copper area to the board's internal ground planes. Liberally distribute these GND vias to provide both a good ground connection and thermal path to the internal planes of the printed circuit board. Pay attention to the location and density of the thermal vias in Figure 2. The LTM8078 can benefit from the heat sinking afforded by vias that connect to internal GND planes at these locations, due to their proximity to internal power handling components. The optimum number of thermal vias depends upon the printed circuit board design. For example, a board might use very small via holes. It should employ more thermal vias than a board that uses larger holes.

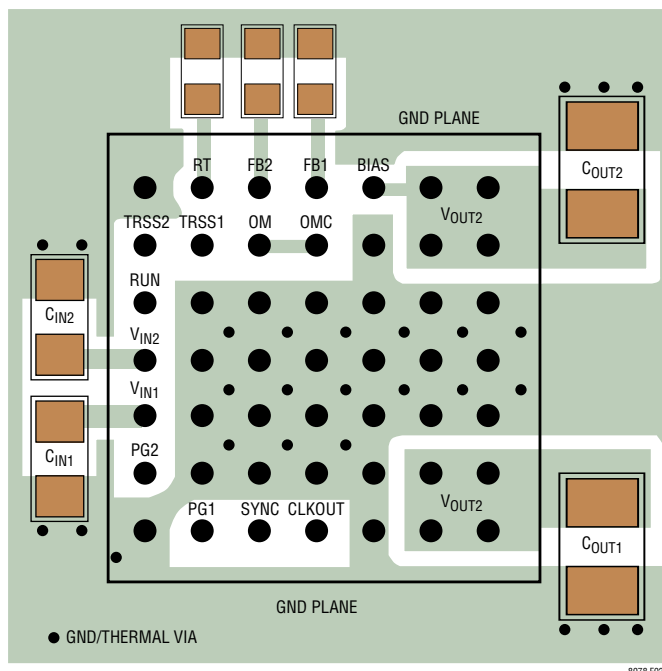


Figure 2. Layout Showing Suggested External Components, GND Plane and Thermal Vias

Hot-Plugging Safely

The small size, robustness and low impedance of ceramic capacitors make them an attractive option for the input bypass capacitor of LTM8078. However, these capacitors can cause problems if the LTM8078 is plugged into a live supply (see Application Note 88 for a complete discussion). The low loss ceramic capacitor combined with stray inductance in series with the power source forms an underdamped tank circuit, and the voltage at the V_{IN} pin of the LTM8078 can ring to more than twice the nominal input voltage, possibly exceeding the LTM8078's rating and damaging the part. If the input supply is poorly controlled or the LTM8078 is hot-plugged into an energized supply, the input network should be designed to prevent this overshoot. This can be accomplished by installing a small resistor in series to V_{IN} , but the most popular method of controlling input voltage overshoot is add an electrolytic bulk cap to the V_{IN} net. This capacitor's relatively high equivalent series resistance damps the circuit and eliminates the voltage overshoot. The extra capacitor improves low frequency ripple filtering and can slightly improve the efficiency of the circuit, though it is likely to be the largest component in the circuit.

Rev. A

APPLICATIONS INFORMATION

Thermal Considerations

The LTM8078 output current may need to be derated if it is required to operate in a high ambient temperature. The amount of current derating is dependent upon the input voltage, output power and ambient temperature. The derating curves given in the Typical Performance Characteristics section can be used as a guide. These curves were generated by the LTM8078 mounted to a 58cm² 4-layer FR4 printed circuit board. Boards of other sizes and layer count can exhibit different thermal behavior, so it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental operating conditions.

For increased accuracy and fidelity to the actual application, many designers use FEA (Finite Element Analysis) or CFD (Computational Fluid Dynamics) to predict thermal performance. To that end, the Pin Configuration typically gives three dominant thermal coefficients:

1. θ_{JA} – Thermal resistance from junction to ambient
2. $\theta_{JCb\text{ot}}$ – Thermal resistance from junction to the bottom of the product case
3. $\theta_{JC\text{top}}$ – Thermal resistance from junction to top of the product case

While the meaning of each of these coefficients may seem to be intuitive, JEDEC has defined each to avoid confusion and inconsistency. These definitions are given in JESD 51-12, and are quoted or paraphrased below:

1. θ_{JA} is the natural convection junction-to-ambient air thermal resistance measured in a one cubic foot sealed enclosure. This environment is sometimes referred to as “still air” although natural convection causes the air to move. This value is determined with the part mounted to a JESD 51-9 defined test board, which does not reflect an actual application or viable operating condition.
2. $\theta_{JCb\text{ot}}$ is the junction-to-board thermal resistance with all of the component power dissipation flowing through the bottom of the package. In the typical μ Module regulator, the bulk of the heat flows out the

bottom of the package, but there is always heat flow out into the ambient environment. As a result, this thermal resistance value may be useful for comparing packages but the test conditions don't generally match the user's application.

3. $\theta_{JC\text{top}}$ is determined with nearly all of the component power dissipation flowing through the top of the package. As the electrical connections of the typical μ Module regulator are on the bottom of the package, it is rare for an application to operate such that most of the heat flows from the junction to the top of the part. As in the case of $\theta_{JCb\text{ot}}$, this value may be useful for comparing packages but the test conditions don't generally match the user's application.

Given these definitions, it should now be apparent that none of these thermal coefficients reflects an actual physical operating condition of a μ Module regulator. Thus, none of them can be individually used to accurately predict the thermal performance of the product. Likewise, it would be inappropriate to attempt to use any one coefficient to correlate to the junction temperature vs load graphs given in the product's data sheet. The only appropriate way to use the coefficients is when running a detailed thermal analysis, such as FEA, which considers all of the thermal resistances simultaneously.

A graphical approximation of these dominant thermal resistances is given in Figure 3. Some thermal resistance elements, such as heat flow out the side of the package, are not defined by the JEDEC standard and are not shown. The blue resistances are contained within the μ Module regulator, and the green are outside.

The die temperature of the LTM8078 must be lower than the maximum rating, so care should be taken in the layout of the circuit to ensure good heat sinking of the LTM8078. The bulk of the heat flow out of the LTM8078 is through the bottom of the package and the pads into the printed circuit board. Consequently a poor printed circuit board design can cause excessive heating, resulting in impaired performance or reliability. Please refer to the PCB Layout section for printed circuit board design suggestions.

APPLICATIONS INFORMATION

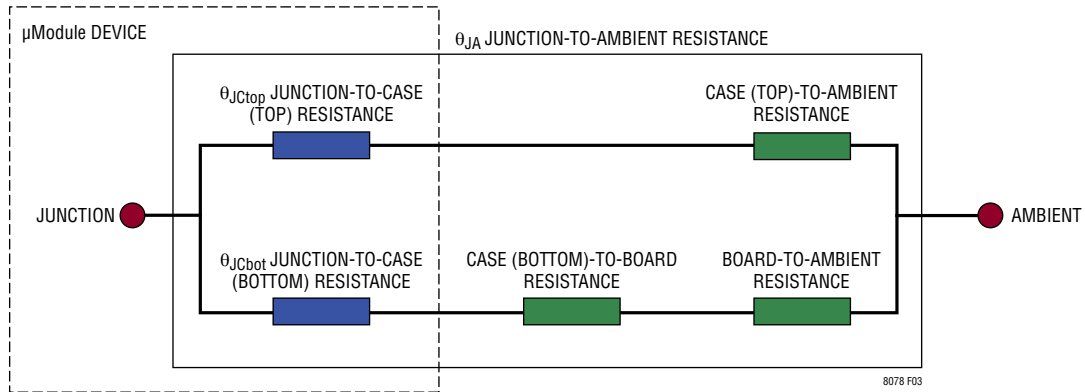
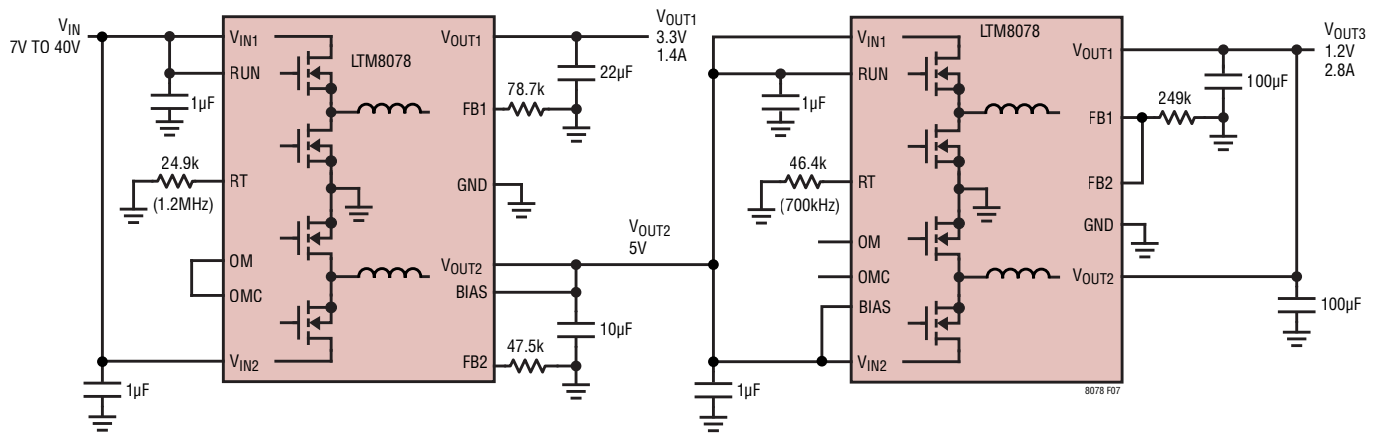


Figure 3. Graphical Representation of Thermal Coefficients, Including JESD51-12 Terms

TYPICAL APPLICATION



PINS NOT USED: TRSS1, TRSS2, PG1, PG2, CLKOUT, SYNC

Figure 4. Cascade Two LTM8078 to Produce 3.3V/1.4A, 1.2V/2.8A from 7V to 40V_{IN}, Both BIAS Pins Are Connected to V_{OUT2}

TYPICAL APPLICATIONS

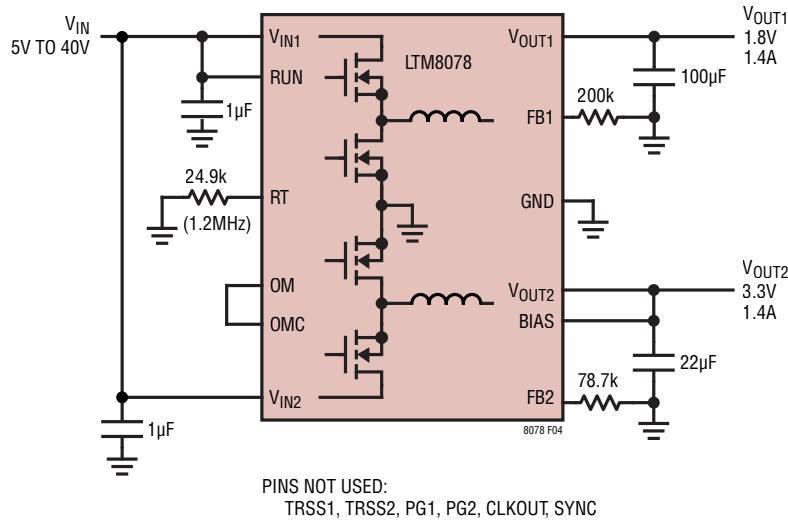


Figure 5. 1.8V/1.4A and 3.3V/1.4A from 5V to 40VIN, BIAS Is Connected to VOUT2

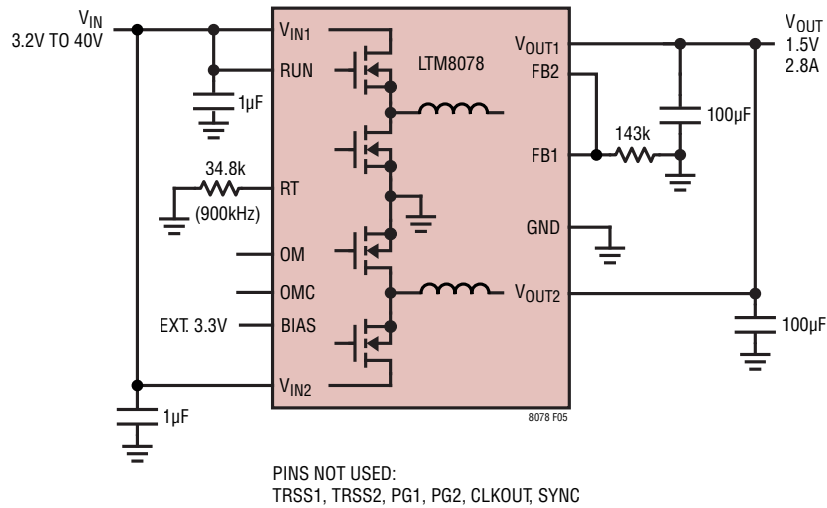


Figure 6. Parallel Two Channels to Produce 1.5V/2.8A from 3.2V to 40VIN, BIAS Is Connected to External 3.3V

TYPICAL APPLICATIONS

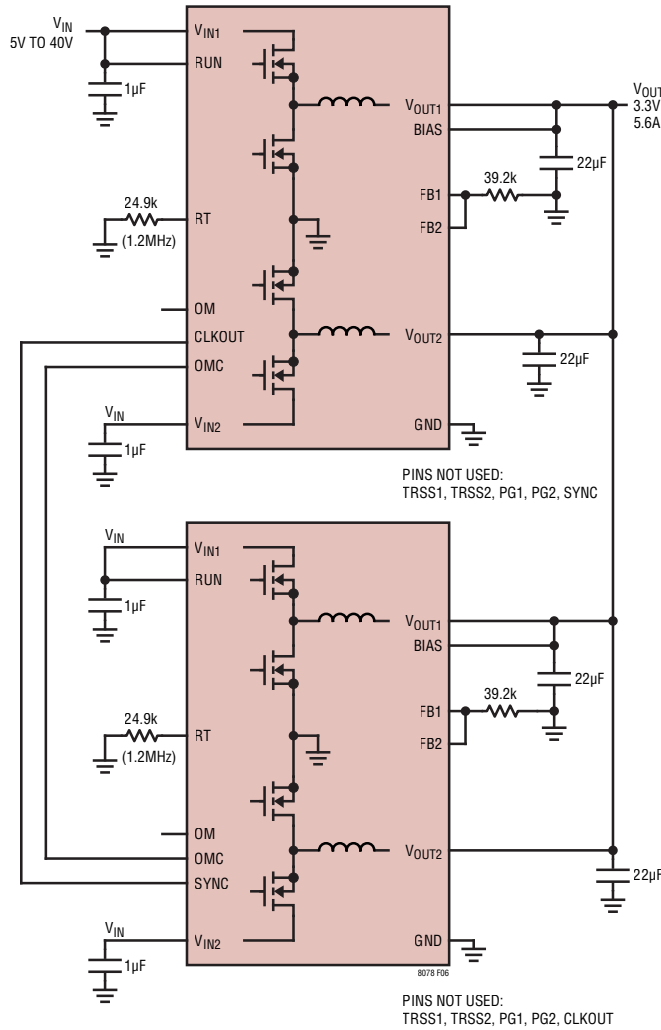


Figure 7. Parallel All Channels of Two LTM8078 to Produce 3.3V/5.6A from 5V to 40V Input, BIAS Connected to V_{OUT}

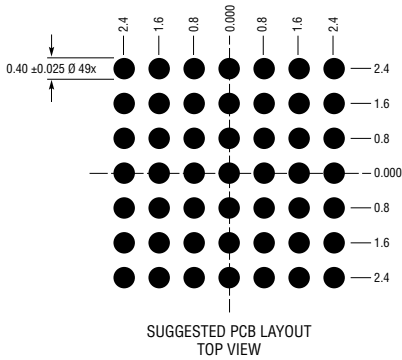
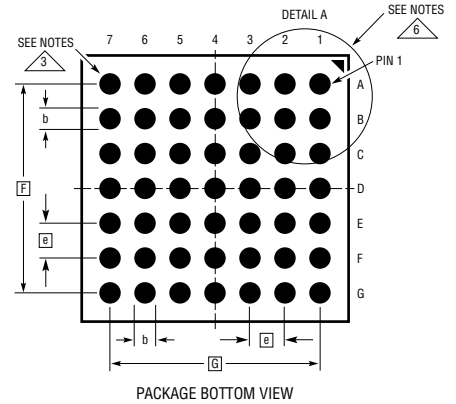
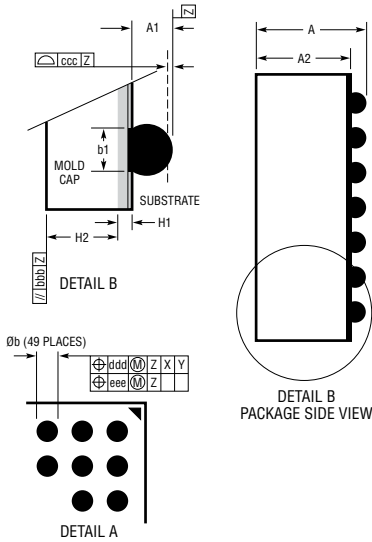
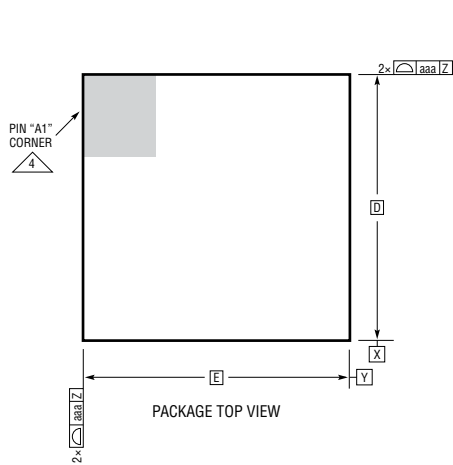
PACKAGE DESCRIPTION

Table 3. LTM8078 Pinout (Sorted by Pin Number)

Pin	Pin Name	Pin	Pin Name	Pin	Pin Name	Pin	Pin Name	Pin	Pin Name	Pin	Pin Name	Pin	Pin Name
A 1	GND	B 1	PG1	C 1	SYNC	D 1	CLKOUT	E 1	GND	F 1	V _{OUT1}	G 1	V _{OUT1}
A 2	PG2	B 2	GND	C 2	GND	D 2	GND	E 2	GND	F 2	V _{OUT1}	G 2	V _{OUT1}
A 3	V _{IN1}	B 3	GND	C 3	GND	D 3	GND	E 3	GND	F 3	GND	G 3	GND
A 4	V _{IN2}	B 4	GND	C 4	GND	D 4	GND	E 4	GND	F 4	GND	G 4	GND
A 5	RUN	B 5	GND	C 5	GND	D 5	GND	E 5	GND	F 5	GND	G 5	GND
A 6	TRSS2	B 6	TRSS1	C 6	OM	D 6	OMC	E 6	GND	F 6	V _{OUT2}	G 6	V _{OUT2}
A 7	GND	B 7	RT	C 7	FB2	D 7	FB1	E 7	BIAS	F 7	V _{OUT2}	G 7	V _{OUT2}

PACKAGE DESCRIPTION

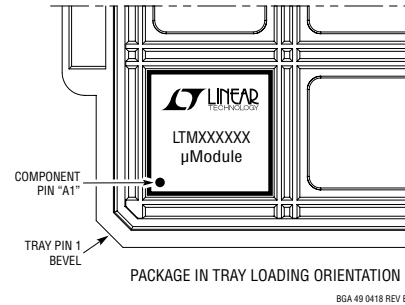
BGA Package 49-Lead (6.25mm × 6.25mm × 2.22mm) (Reference LTC DWG# 05-08-1518 Rev B)



DIMENSIONS				
SYMBOL	MIN	NOM	MAX	NOTES
A	2.02	2.22	2.42	
A1	0.30	0.40	0.50	BALL HT
A2	1.72	1.82	1.92	
b	0.45	0.50	0.55	BALL DIMENSION
b1	0.37	0.40	0.43	PAD DIMENSION
D		6.25		
E		6.25		
e		0.80		
F		4.80		
G		4.80		
H1		0.32 REF		SUBSTRATE THK
H2		1.50 REF		MOLD CAP HT
aaa			0.15	
bbb			0.10	
ccc			0.20	
ddd			0.15	
eee			0.08	

TOTAL NUMBER OF BALLS: 49

- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. ALL DIMENSIONS ARE IN MILLIMETERS
 3. BALL DESIGNATION PER JEP95
 4. DETAILS OF PIN #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE PIN #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE
 5. PRIMARY DATUM -Z- IS SEATING PLANE
 6. PACKAGE ROW AND COLUMN LABELING MAY VARY AMONG µModule PRODUCTS. REVIEW EACH PACKAGE LAYOUT CAREFULLY

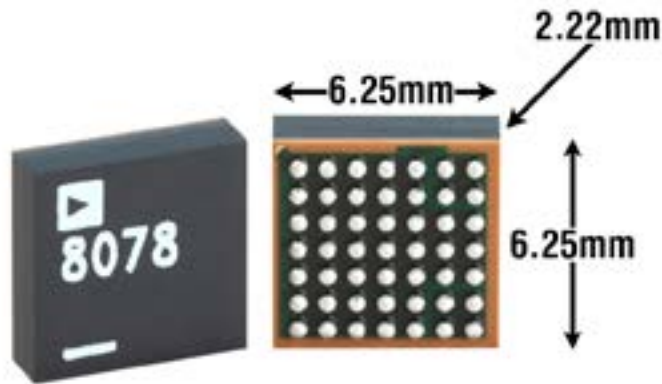


BGA 49 0418 REV B

REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	03/20	Added LTM8078IY in Order Information	2
		Added More Power Loss and Radiated EMI Graphs	5-6, 11
		Added Bias Current (mA) vs Switching Frequency (MHz) Graph	8
		Added Output Voltage Ripple DC2777A Demo Board Graph	12
		Added Output Noise Spectrum DC2777A, 100kHz, 10MHz and 500MHz Span Performance Graphs	12
		Added CISPR25 Radiated Emission with Class 5 Average Limit DC2777A Demo Board Graphs	12

PACKAGE PHOTOGRAPH



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTM8074	40V, 1.2A Silent Switcher μ Module Regulator	$3.2V \leq V_{IN} \leq 40V$, $0.8V \leq V_{OUT} \leq 12V$, 4mm \times 4mm \times 1.82mm BGA
LTM8063	40V, 2A Step-Down Silent Switcher μ Module Regulator	$3.2V \leq V_{IN} \leq 40V$, $0.8V \leq V_{OUT} \leq 15V$, 4mm \times 6.25mm \times 2.22mm BGA Package
LTM8065	40V, 2.5A Step-Down Silent Switcher μ Module Regulator	$3.4V \leq V_{IN} \leq 40V$, $0.97V \leq V_{OUT} \leq 18V$, 6.25mm \times 6.25mm \times 2.32mm BGA Package
LTM8053	40V, 3.5A Step-Down μ Module Regulator	$3.4V \leq V_{IN} \leq 40V$, $0.97V \leq V_{OUT} \leq 15V$, 6.25mm \times 9mm \times 3.32mm BGA
LTM8003	40V, 3.5A, H-Grade, 150°C Operation, FMAE-Compliant Pinout	$3.4V \leq V_{IN} \leq 40V$, $0.97V \leq V_{OUT} \leq 15V$, $I_{OUT} = 3.5A$, 6.25mm \times 9mm \times 3.32mm BGA
LTM8052	36V, 5A CVCC Step-Down μ Module Regulator	$6V \leq V_{IN} \leq 36V$, $1.2V \leq V_{OUT} \leq 24V$, Constant Voltage Constant Current, 11.25mm \times 15mm \times 2.82mm LGA, 11.25mm \times 15mm \times 3.42mm BGA
LTM4613	36V, 8A Low EMI Step-Down μ Module Regulator	$5V \leq V_{IN} \leq 36V$, $3.3V \leq V_{OUT} \leq 15V$, EN55022B Compliant, 15mm \times 15mm \times 4.32mm LGA, 15mm \times 15mm \times 4.92mm BGA.
LTM8073	60V, 3A Step-Down μ Module Regulator	$3.4V \leq V_{IN} \leq 60V$, $0.85V \leq V_{OUT} \leq 15V$, 6.25mm \times 9mm \times 3.32mm BGA
LTM8071	60V, 5A Silent Switcher μ Module Regulator	$3.6V \leq V_{IN} \leq 60V$, $0.97V \leq V_{OUT} \leq 15V$, 9mm \times 11.25mm \times 3.32mm BGA
LTM4622	Dual 2.5A, 20V Step-Down μ Module Regulator	$3.6V \leq V_{IN} \leq 20V$, $0.6V \leq V_{OUT} \leq 5.5V$, 6.25mm \times 6.25mm \times 1.82mm LGA, 6.25mm \times 6.25mm \times 2.42mm BGA
LTM4642	Dual 4A, 20V Step-Down μ Module Regulator	$4.5V \leq V_{IN} \leq 20V$, $0.6V \leq V_{OUT} \leq 5.5V$, 9mm \times 11.25mm \times 4.92mm BGA
LTM4643	Quad 3A, 20V Step-Down μ Module Regulator	$4V \leq V_{IN} \leq 20V$, $0.6V \leq V_{OUT} \leq 3.3V$, 9mm \times 15mm \times 1.82mm LGA, 9mm \times 15mm \times 2.42mm BGA
LTM4644	Quad 4A, 14V Step-Down μ Module Regulator	$4V \leq V_{IN} \leq 14V$, $0.6V \leq V_{OUT} \leq 5.5V$, 9mm \times 15mm \times 5.01mm BGA
LTM8024	40V _{IN} , Dual 3.5A or Single 7A Silent Switcher μ Module Regulator	$3V \leq V_{IN} \leq 40V$, $0.8V \leq V_{OUT} \leq 8V$, 9mm \times 11.25mm \times 3.32mm BGA Package

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